



Document Number: CII-CI-XXXX Version: Rev A Draft

Common Instrument Interface Project

Hosted Payload Guidelines Document

Earth System Science Pathfinder Program Office NASA Langley Research Center Hampton, VA 23681

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3 Change Log

Version	Date	Section Affected	Description
Rev A	11-26-2012	All	Incorporated GEO guidelines
Rev A	11-26-2012	All	Reorganized document to delineate Level 1 guidelines, Level 2 guidelines, and Best Practices
Rev A	11-26-2012	All	Added Hosted Payload Concept of Operations
Rev A	02-15-2013	All	Updated document based upon stakeholder feedback from December 2012 CII Working Group Meeting

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114 1.0 OVERVIEW

115 1.1 Introduction

- 116 These Common Instrument Interface (CII) Hosted Payloads Guidelines provide a prospective
- 117 Instrument Developer with technical recommendations to help them design an Instrument that
- may be flown as a hosted payload either in Low Earth Orbit (LEO) or Geostationary Earth Orbit
- 119 (GEO).
- 120 NASA Earth Science has implemented its Earth Venture Instrument (EVI) line of missions using
- a hosted payload model. Therefore, these guidelines primarily support stakeholders involved in
- 122 NASA's EVI suite of investigations.
- NASA competitively selects Principal Investigator (PI)-led EVI investigations via solicitations
- that "call for developing instruments for participation on a NASA-arranged spaceflight mission
- of opportunity to conduct innovative, integrated, hypothesis or scientific question-driven
- approaches to pressing Earth system science issues." The deliverables of a selected investigation
- includes "a flight qualified spaceflight instrument or instrument package ready for integration to
- a spacecraft, technical support for integration onto a NASA-determined spacecraft, and on-orbit
- operation of the instrument and delivery of science quality data." Prospective PI's propose their
- 130 Instrument "without a firm identification of the spacecraft to accommodate it," and NASA
- deploys the selected Instrument on an existing planned spacecraft (Host Spacecraft).
- This guideline document focuses on the technical aspects of flying an Earth Science Instrument
- on a Hosted Payload Opportunity (HPO). Because of the nature of the EVI acquisition strategy,
- 134 Instrument Developers and Spacecraft Manufacturers proceed along the early stages of their
- respective product lifecycles independently. By vetting these technical parameters with space
- industry stakeholders, the CII team hopes to ensure maximum compatibility with the Earth-
- orbiting spacecraft market, leading to an increased likelihood of a successful Instrument to HPO
- 138 pairing.
- 139 Instrument Developers are not required to comply with these guidelines. These guidelines are
- not met to replace Instrument Developer collaboration with Spacecraft Manufacturers, rather to
- provide familiarity of Spacecraft interfaces and accommodations in order to assist with such
- 142 collaboration. Instrument parameters that exceed values specified in this guidance may very well
- be accommodated with additional resources that offset the impact to existing HPO designs (e.g.,
- investments enhancing Instrument capability) or that propose to enable compatibility after minor
- alterations to spacecraft performance (e.g., investments enhancing Spacecraft capability). It is
- 146 ultimately the responsibility of the Instrument Provider to investigate such cost-benefit
- 147 considerations during proposal development.

¹ "Earth Venture Instrument-1," from Program Element Appendix (PEA) J of the Second Stand Alone Missions of Opportunity Notice (SALMON-2), 2012.

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148 1.2 Nomenclature and Definitions

- 149 The verb "should" denotes a recommendation. "Shall" denotes a requirement. "Will" denotes
- 150 an expected future event.
- 151 Hosted Payload: a payload manifested on a spacecraft bus flying on a primary space mission.
- 152 Hosted Payload Opportunity: a spacecraft bus flying on a primary space mission with surplus
- 153 resources to accommodate a hosted payload.
- 154 Instrument: the hosted payload of record that these guidelines describe.
- 155 Instrument Developer: the organization responsible for developing and building the Instrument
- 156 itself.
- 157 Host Spacecraft: the Hosted Payload Opportunity spacecraft bus of record that these guidelines
- 158 describe.
- 159 Host Spacecraft Manufacturer: the organization responsible for manufacturing the Host
- 160 Spacecraft and the primary commercial payloads.
- 161 Satellite Operator: the organization responsible for on-orbit and ground operations throughout
- 162 the Host Spacecraft's lifetime.
- 163 Systems Integrator: the organization responsible for integrating the Instrument and Host
- 164 Spacecraft.

165 1.3 **Methodology**

- 166 The content of this document is aggregated from several sources. The CII team used personal
- 167 engineering experience, publicly available information, and privately held information shared by
- 168 industry to define the primary technical components structuring this document and to establish
- 169 its content. The CII team leveraged stakeholder feedback and numerous peer review workshops
- 170 to guide efforts seeking to establish appropriate breadth and depth of the source material for the
- 171 guidelines document. In order to increase the likelihood that a guideline-compliant Instrument
- 172
- design would technically fit within the accommodation space of an HPO, the CII team used an
- 173 "all-satisfy" strategy. Specifically, for each technical performance measure, guidance is
- 174 generally prescribed by the most restrictive value from the set of likely spacecraft known to
- 175 operate in both the LEO and GEO domains. This strategy was again generally utilized to
- 176 characterize environments, whereby the most strenuous environment expected in both the LEO
- 177 and GEO domains inform best practices. Where considered necessary, the CII team based
- 178 environmental guidance on independent modeling of particular low Earth orbits that are
- 179 commonly considered advantageous in supporting Earth science measurements.
- 180 This methodology also allows for the sanitization of industry proprietary data. The set of
- 181 expected LEO spacecraft is based upon the Rapid Spacecraft Development Office Catalog
- 182 (http://rsdo.gsfc.nasa.gov/catalog.html), tempered by CII analyses of NASA databases and
- 183 Communities of Practice. Smaller spacecraft (including microsatellites or secondary platforms)

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are not precluded from host consideration. The set of expected GEO spacecraft is based upon
 industry responses to the *Request for Information for Geostationary Earth Orbit Hosted Payload* Opportunities.

One limitation of the "all-satisfy" strategy is that it constrains all instrument accommodation parameters to a greater degree than should be expected once the Instrument is paired with a Host Spacecraft. One size does not fit all in Hosted Payloads, especially in the GEO domain where the bus sizes vary among and within Spacecraft Manufacturers. Additionally, because a Spacecraft Manufacturer tailors its bus design to each Satellite Operator's requirements, Instrument Developers may be able to negotiate an agreement for the Spacecraft Manufacturer to supply or for the Satellite Operator to require a larger bus or upgraded spacecraft performance than originally specified for the Satellite Operator. This enables the Host Spacecraft to accommodate more demanding Instrument requirements, given the application of enough resources. Because the Instrument to Host Spacecraft pairing occurs in the vicinity of Key Decision Point (KDP) C, certain knowledge of these available accommodation resources will be delayed well into the Instrument's development timeline.

1.4 Interpretation

The content of this document represents recommendations, not requirements. These recommendations aid Instrument Developers proposing to EVI AO's by documenting the CII team's analysis of the interfaces and resource demands most likely to be accommodated on LEO and GEO HPO's. While the EVI–1 AO references the CII guidelines and HPO database as "activities that document ... the types of opportunities that exist and the current interfaces and constraints that exist for each potential platform," it does not state that compliance with the CII guidelines is mandatory. The CII Team's expects that future EVI AO's will use the same model. The CII Team has limited the depth of guidelines to strike a balance between providing enough technical information to add value to a Pre-Phase A (Concept Studies) project and not overly constraining the Instrument design. This allows for a design sufficiently fungible to adapt to expected HPO's and limits any (incorrectly inferred) compliance burdens.

While this document focuses on the technical aspects of hosted payloads, it is noteworthy that programmatic and market-based factors are likely more critical to the success of a hosted payload project than technical factors. When paired with commercial satellites, NASA can take advantage of the commercial space industries best practices and profit incentives to fully realize the benefits of hosted payloads. Because an EVI Instrument would neither be the primary payload or financial contributor on the Host Spacecraft, NASA may relinquish some of the oversight and decision rights it traditionally exerts in a dedicated mission. This leads to the "Do No Harm" concept explained in the Level 1 Design Guidelines. With this exception, programmatic and business aspects of hosted payloads are outside the scope of this document.

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² "Earth Venture Instrument-1," from Program Element Appendix (PEA) J of the Second Stand Alone Missions of Opportunity Notice (SALMON-2), 2012.

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1.5 **Scope**

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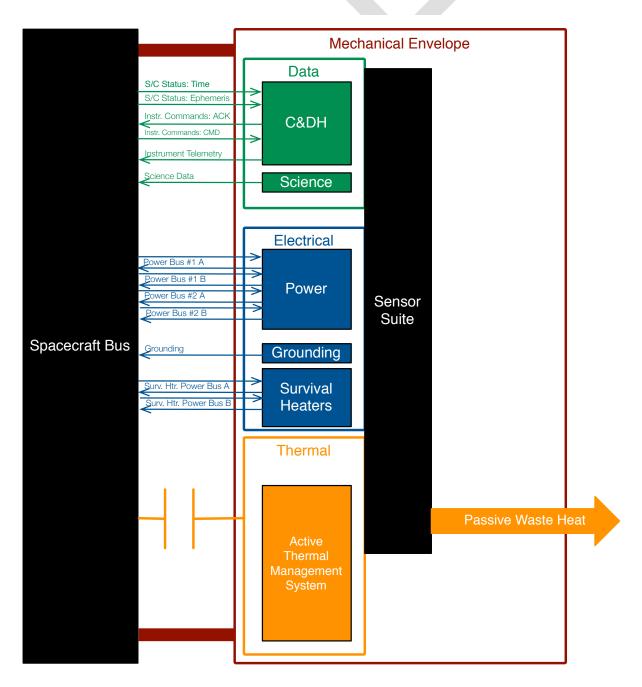
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This document's scope comprises five primary technical components of the Instrument to Host Spacecraft pairing: interface, accommodations, best practices, assumptions, and negotiated parameters. Figure 1-1 uses color to identify the scope: colored components are in scope; black components are out of scope.



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Figure 1-1: CII Scope

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227 Interface guidelines describe the direct interactions between the Instrument and Host Spacecraft, 228 such as physical connections and transfer protocols. Accommodation guidelines describe the 229 constraints on the resources and services the Instrument is expected to draw upon from the Host 230 Spacecraft, including size, mass, power, and transmission rates. While guidelines are not 231 requirements—using the verb "should" instead of "shall"—they try to follow the rules of writing 232 proper requirements, including providing rationale and maintaining traceability to higher level 233 guidelines. This document provides two hierarchical levels of guidelines, because suggesting 234 more specific technical details in the context of a hosted payload with not yet identified 235 stakeholders is not credible 236 The best practices capture additional technical information, less prescriptive than the guidelines, 237 which an Instrument Developer might still find useful. 238 Assumptions are generally expectations of the characteristics and behavior of the Host Spacecraft and/or Host Spacecraft Manufacturer. Since Instrument requirement definition and 239 240 design will likely happen prior to identification of the Host Spacecraft, these assumptions help 241 bind the trade space. 242 Negotiated parameters reflect the effect of the Host Spacecraft and Instrument beginning 243 development simultaneously and independently—some parameters will not be resolved prior to 244 the Host Spacecraft to Instrument pairing. This document uses an Interface Control Document (ICD) construct as the means to record agreements reached among the Instrument Developer, 245 246 Host Spacecraft Manufacturer, Launch Vehicle Provider, and Satellite Owner. 247 This document's recommendations cover both the LEO and GEO domains. If a guideline or best 248 practice is specific to one of the domains, it begins with either the [LEO] or [GEO] prefix. 249 Guidelines or best practices without prefixes apply to both domains. 250 1.6 **Revisioning** 251 The Earth System Science Pathfinder (ESSP) Program Office released the Baseline version of 252 CII guideline document, which only addressed interfaces for LEO platforms, in November 2011 253 in preparation for the EVI-1 AO. This Revision A version precedes the EVI-2 AO, providing 254 more explicit definition of guideline scope and technical components, incorporating technical 255 content for the GEO domain, and reducing design constraints on the Instrument Developer. 256 The CII Team plans to release updated guidelines preceding each future EVI AO release. This 257 forward approach will ensure this document's guidance reflects current technical interface 258 capabilities of commercial spacecraft manufacturers and maintains cognizance of industry-wide 259 design practices resulting from technological advances (e.g. xenon ion propulsion). 260 1.7 Interaction with Other Agencies Involved with Hosted Payloads 261 A measure of success for these guidelines is that they will have a broad acceptance among 262 different communities and agencies. The Air Force Space and Missile Systems Center recently

stood up a Hosted Payload Office (SMC/XRFH) to evaluate HPO's as a distributed, resilient

option within operational architectures. The European Space Agency's (ESA) Future Missions

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Division of their Earth Observation Progra concept for their future missions. Both org standards, although one important note is t requirements as opposed to the CII recomm	ganizations are currently developin hat the SMC and ESA elements whended guidelines.	g hosted payload ill be prescriptive
The CII team has been working very closely with ESA over the past couple of years on a unified set of guidelines for electrical power and data interfaces in the LEO domain. Due to different sets of common practices in the American and European space industries, a small number of technical differences exist between the CII and ESA guidelines.		
Similarly, the CII team has been collaborating with SMC/XRFH to minimize the differences in CII top-level guidelines and SMC requirements. The SMC requirements are currently in development. Future versions of the CII document will summarize the differences with the SMC requirements once they are finalized.		

277 Appendix H summarizes these differences in tabular form.

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278 2.0 LEVEL 1 DESIGN GUIDELINES

- 279 The Common Instrument Interface has eleven Level 1 guidelines. These Level 1 guidelines are
- 280 the highest guidelines in the hierarchy, and the rest of the lower-level guidelines depend on
- 281 these.
- 282 2.1 Assumptions
- 283 2.1.1 <u>Hosted Payload</u>: The Host Spacecraft will have a primary mission different than that
- of the Instrument.
- 285 2.1.2 [GEO] Nominal Orbit: The Host Spacecraft will operate in GEO with an altitude of
- approximately 35786 kilometers and eccentricity and inclination of approximately zero.
- 287 2.1.3 [LEO] Nominal Orbit: The Host Spacecraft will operate in LEO with an altitude
- between 350 and 2000 kilometers with eccentricity less than 1 and inclination between zero and
- 289 180°, inclusive.
- 290 2.1.4 Responsibility for Integration: The Host Spacecraft Manufacturer will integrate the
- Instrument onto the Host Spacecraft with support from the Instrument Developer.
- 292 2.2 Guidelines
- 293 2.2.1 Hosted Payload Worldview
- 294 The Instrument should prevent itself or any of its components from damaging or otherwise
- degrading the mission performance of the Host Spacecraft or any other payloads.
- 296 Rationale: The most important constraint on a hosted payload is to "do no harm" to the Host
- 297 Spacecraft or other payloads. The Satellite Operator will have the authority to remove power or
- otherwise terminate the Instrument should either the Host Spacecraft's available services degrade
- or the Instrument pose a threat to the rest of the Spacecraft. This guideline applies over the
- 300 period beginning at the initiation of Instrument integration to the Host Spacecraft and ending at
- 301 the completion of the disposal of the Host Spacecraft. It is important to note that most GEO
- 302 communications satellites have a nominal mission lifetime in excess of 15 years or more while a
- hosted payload Instrument nominal lifetime is on the order of five years.
- 304 2.2.2 Data Interface
- 305 [LEO] The Instrument-to-Host Spacecraft data interfaces should use RS-422, SpaceWire,
- 306 or MIL-STD-1553.
- Rationale: RSS-422, SpaceWire, and MIL-STD-1553 are commonly accepted spacecraft data
- 308 interfaces.
- 309 [GEO] The Instrument should use MIL-STD-1553 as the command and telemetry data
- 310 interface with the Host spacecraft.
- Rationale: The use of MIL-STD-1553 for command and telemetry is nearly universal across
- 312 GEO spacecraft buses.
- 313 [GEO] The Instrument should send science data directly to its transponder via an RS-422,
- 314 LVDS, or SpaceWire interface.

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- Rationale: The use of RS-422, LVDS, or SpaceWire directly to a transponder for high-volume
- payload data is a common practice on GEO spacecraft buses.
- 317 2.2.3 Data Accommodation
- 318 [LEO] The Instrument should transmit less than 10 Mbps of data on average to the Host
- 319 Spacecraft. Data may be transmitted periodically in bursts of up to 100 Mbps.
- Rationale: CII analysis of the NICM Database (see Appendix E) shows 10 Mbps to be the upper
- bound for instruments likely to find rides as LEO hosted payloads. Many spacecraft data buses
- are run at signaling rates than can accommodate more than 10 Mbps. While this additional
- 323 capacity is often used to share bandwidth among multiple payloads, it may also be used for
- 324 periodic burst transmission when negotiated with the Host Spacecraft Providers and/or
- Operators. When sizing Instrument data volume, two considerations are key: 1) The Instrument
- should not assume the Host Spacecraft will provide any data storage (see guideline 4.3.1), and 2)
- 327 LEO downlink data rates vary considerably depending upon the antenna frequencies employed
- 328 (e.g. S-Band is limited to 2 Mbps while X-Band and Ka-Band may accommodate 100 Mbps or
- 329 more).
- 330 [GEO] The Instrument should utilize less than 500 bps of MIL-STD-1553 bus bandwidth
- when communicating with the Host Spacecraft.
- Rationale: The MIL-STD-1553 maximum 1 Mbps data rate is a shared resource. Most
- spacecraft buses provide between 250 bps and 2 kbps for commanding and up to 4 kbps for
- telemetry for all instruments and components on the spacecraft bus. Telemetry that is not critical
- 335 to the health and safety of either the Instrument or Host Spacecraft does not need to be monitored
- by the Satellite Operator and therefore may be multiplexed with Instrument science data.
- 337 [GEO] The Instrument should transmit less than 60 Mbps of science data to its
- 338 transponder.
- Rationale: Transponder bandwidth is a function of lease cost and hardware capability. Data rates
- in the range of 60-80 Mbps for a single transponder are common. Higher data rates can be
- achieved with multiple transponders (at an increased cost).
- 342 2.2.4 Electrical Power System Interface
- The Instrument should electrically ground to a single point on the Host Spacecraft.
- Rationale: The Instrument Electrical Power System (EPS) should ground in a way that reduces
- 345 the potential to introduce stray currents or ground loop currents into the Instrument, Host
- 346 Spacecraft, or other payloads.
- 347 2.2.5 Electrical Power System Accommodation
- 348 [LEO] The Instrument EPS should draw less than or equal to 100W, averaged over the
- 349 orbit, from the Host Spacecraft.

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Rationale: CII analysis of the NICM Data bound for instruments likely to find rides	` 11	W to be the upper
[LEO] The Instrument EPS should acc	cept an unregulated input voltag	ge of 28 ± 6 VDC.
Rationale: The EPS architecture is consis available nominal voltage being 28 Volts regulated) configuration.		
[GEO] The Instrument should draw le the Host Spacecraft.	ess than or equal to 300W of elec	trical power from
Rationale: The Host Spacecraft available manufacturer and by spacecraft bus confithe Primary Manufacturers' buses can ac increases the likelihood of funding a suita	guration. 300 Watts represents a percommodate, and requiring a power	power level that all of
[GEO] The Instrument EPS should ac	cept a regulated input voltage of	f 28 \pm 3 VDC.
Rationale: Host Spacecraft bus voltages v with the following nominal voltages: 28, conversion efficiency and available hostin lowest nominal voltage provided, which is	36, 50, 70, and 100 VDC. To manning opportunities, the Instrument sh	ximize both voltage
Note: this guideline may be superseded by power requirements or by "resistance only		pecific voltage or
[GEO] The Instrument payload prima other "resistance only" power circuits to payload EPS should accommodate the voltage tolerance.	that are separable subsystems of	f the Instrument
Rationale: Host Spacecraft bus voltages v with the following nominal voltages: 28, power required to be converted to an input hosting opportunities, an Instrument Deve accept the spacecraft bus nominal voltage	36, 50, 70, and 100 VDC. To minut voltage of 28 ± 3 VDC and to meloper should design "resistance of the state of the st	nimize the amount of aximize the available

Thermal Interface

The Instrument should be thermally isolated from the Host Spacecraft.

³ In the context of this guideline, the Primary Manufacturers are the spacecraft manufacturers who responded to the CII RFI for GEO Hosted Payload Opportunities. They comprise more than 90% of the GEO commercial satellite market, based upon spacecraft either on-orbit or with publically-announced satellite operator contracts.

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- Rationale: As a hosted payload, the Instrument should manage its own heat transfer needs
- without depending on the Host Spacecraft. The common practice in the industry is to thermally
- isolate the payload from the spacecraft.
- 383 2.2.7 Mechanical Interface
- The Instrument should be capable of fully acquiring science data when directly mounted to
- 385 the Host Spacecraft nadir deck.
- Rationale: Assessments of potential LEO Host Spacecraft and the responses to the CII RFI for
- 387 GEO Hosted Payload Opportunities indicate nadir-deck mounting of hosted payloads can be
- 388 accommodated. Alternative mechanical interface locations or kinematic mounts are not
- prohibited by this guidance but may increase interface complexity.
- 390 2.2.8 Mechanical Accommodation
- 391 [LEO] The Instrument mass should be less than or equal to 100 kg.
- 392 Rationale: Analysis of the NICM database indicates that a 100kg allocation represents the upper
- 393 bound for potential hosted payloads.
- 394 [GEO] The Instrument mass should be less than or equal to 150 kg.
- 395 Rationale: Analysis of the responses to the CII RFI for GEO Hosted Payload Opportunities
- indicate an instrument of up to 150 kg can be accommodated with minimal impact to existing
- 397 spacecraft design and function. Instruments exceeding 150 kg can be accommodated but may
- require additional resources to address growing impacts to existing designs.
- 399 2.2.9 [GEO] Attitude Control System Pointing Accommodation
- 400 The Instrument 3σ pointing accuracy required should exceed 1440 seconds of arc (0.4)
- degrees) in each of the Host Spacecraft roll, pitch, and yaw axes.
- 402 Rationale: The Host Spacecraft bus pointing accuracy varies significantly both by manufacturer
- and by spacecraft bus configuration. 1440 arc-seconds represents a pointing accuracy that all of
- 404 the Primary Manufacturers' buses can achieve. If an Instrument requires a pointing accuracy
- 405 that is equivalent to or less stringent than this value, then the likelihood of finding a suitable Host
- 406 Spacecraft increases significantly.
- 407 2.2.10 [GEO] Attitude Determination System Pointing Knowledge Accommodation
- 408 The Instrument 3σ pointing knowledge required should exceed 450 seconds of arc (0.125)
- degrees) in the Host Spacecraft roll and pitch axes and 900 seconds of arc (0.25 degrees) in
- 410 the yaw axis.
- 411 Rationale: The Host Spacecraft bus pointing knowledge varies significantly both by
- manufacturer and by spacecraft bus configuration. 450 arc-seconds (roll/pitch) and 900 arc-
- seconds (yaw) represent a pointing knowledge that all of the Primary Manufacturers' buses can
- 414 achieve. If an Instrument requires a pointing knowledge that is equivalent to or less stringent
- 415 than this value, then the likelihood of finding a suitable Host Spacecraft increases significantly.

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- 416 2.2.11 [GEO] Payload Pointing Stability Accommodation
- The Instrument should require a short term ($\geq 0.1 \text{ Hz}$) 3σ pointing stability that is greater
- 418 than or equal to 110 seconds of arc/second (0.03 degrees/second) in each spacecraft axis and
- a long term (Diurnal) 3σ pointing stability that is greater than or equal to 440 seconds of
- arc (0.12 degrees/second) in each spacecraft axis.
- 421 Rationale: Host Spacecraft pointing stability varies significantly both by manufacturer and by
- bus configuration. In order to maximize the probability of matching an available hosting
- opportunity, an instrument should be compatible with the maximum pointing stability defined for
- 424 all responding Host Spacecraft Manufacturers' buses and configurations. According to
- information provided by industry, the level of short term (≥ 0.1 Hz) pointing stability available
- for secondary hosted payloads is ≤ 110 seconds of arc/second (0.03 degrees/second) in each of
- 427 the spacecraft axes. The level of long term (Diurnal) pointing stability available for secondary
- 428 hosted payloads is \leq 440 seconds of arc/second (0.12 degrees/second) in each of the spacecraft
- 429 axes. Therefore, an Instrument pointing stability requirement greater than these values will
- ensure that any prospective Host Spacecraft bus can accommodate the Instrument.
- 431 2.2.12 Environmental Interface
- 432 The Instrument should be compatible with and function according to its operational
- 433 specifications in those environments encountered during Shipping/Storage, Integration and
- 434 Test, Launch, and Operations as defined in Section 8.0.
- Rationale: From the time the Instrument departs the facility in which it was constructed through
- on-orbit operations and decommissioning, it will encounter disparate environments with which it
- 437 needs to be compatible with and function reliably and predictably.
- 438 2.2.13 Instrument Models
- 439 The Instrument Developer should submit finite element, thermal math, mechanical
- computer aided design, and mass models of the instrument to the Host Spacecraft
- 441 manufacturer/integrator.
- Rationale: The Host Spacecraft manufacturer/integrator requires models of all spacecraft
- components in order to complete the design portion of the spacecraft lifecycle.

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444 3.0 HOSTED PAYLOAD WORLDVIEW LEVEL 2 GUIDELINES

- 445 3.1 Mission Risk
- 446 The Instrument should comply with Mission Risk Class C safety and mission assurance
- requirements, in accordance with NPR 8705.4.
- Rationale: NPR 8705.4 assigns Class C to medium priority, medium risk payloads, with medium
- 449 to low complexity, short mission lifetime, and medium to low cost. The EVI-1 Announcement
- of Opportunity solicited "... proposals for science investigations requiring the development and
- operation of space-based instruments, designated as Class C on a platform to be identified by
- 452 NASA at a later date."⁴
- 453 3.2 Instrument End of Life
- 454 The Instrument should place itself into a "safe" configuration upon reaching its end of life
- 455 to prevent damage to the Host Spacecraft or any other payloads.
- 456 Rationale: The Instrument may have potential energy remaining in components such as pressure
- vessels, mechanisms, batteries, and capacitors, from which a post-retirement failure might cause
- damage to the Spacecraft Host or its payloads. The Instrument Developer should develop, in
- 459 concert with the Host Spacecraft and the Satellite Operator, an End of Mission Plan that specifies
- 460 the actions that the Instrument payload and Host Spacecraft will take to "safe" the Instrument
- payload by reduction of potential energy once either party declares the Instrument's mission
- 462 "Complete."
- 463 3.3 Prevention of Failure Back-Propagation
- The Instrument and all of its components should prevent anomalous conditions, including
- failures, from propagating to the Host Spacecraft or other payloads.
- Rationale: The Instrument design should isolate the effects of Instrument anomalies and failures.
- such as power spikes, momentum transients, and electromagnetic interference so that they are
- 468 contained within the boundaries of the Instrument system.

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⁴ "Earth Venture Instrument-1," from Program Element Appendix (PEA) J of the Second Stand Alone Missions of Opportunity Notice (SALMON-2), 2012.

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469 4.0 DATA LEVEL 2 GUIDELINES

470 4.1 Assumptions

- The CII data guidelines assume the following regarding the Host Spacecraft:
- During the matching process, the Host Spacecraft Manufacturer/Systems Integrator and the Instrument Developer will negotiate detailed parameters of the data interface. The Data Interface Control Document (DICD) will record those parameters and decisions.

475 4.2 Data Interface Guidelines

- 476 4.2.1 Command Dictionary
- 477 The Instrument Provider should provide a command dictionary to the Host Spacecraft
- 478 Manufacturer, the format and detail of which will be negotiated with the Host Spacecraft
- 479 Manufacturer.
- 480 Rationale: Best practice and consistent with DICD. A command dictionary defines all
- instrument commands in detail, by describing the command, including purpose, preconditions,
- possible restrictions on use, command arguments and data types (including units of measure, if
- applicable), and expected results (e.g. hardware actuation and/or responses in telemetry) in both
- nominal and off-nominal cases. Depending on the level of detail required, a command dictionary
- may also cover binary formats (e.g. packets, opcodes, etc.).
- 486 4.2.2 <u>Telemetry Dictionary</u>
- 487 The Instrument Provider should provide a telemetry dictionary to the Host Spacecraft
- 488 Manufacturer, the format and detail of which will be negotiated with the Host Spacecraft
- 489 Manufacturer.
- 490 Rationale: Best practice and consistent with DICD. A telemetry dictionary defines all
- information reported by the instrument in detail, by describing the data type, units of measure,
- and expected frequency of each measured or derived value. If telemetry is multiplexed or
- otherwise encoded (e.g. into virtual channels), the telemetry dictionary will also describe
- decommutation procedures which may include software or algorithms. By their nature,
- 495 telemetry dictionaries often detail binary packet formats.
- 496 4.2.3 SAFE mode
- 497 The Instrument should provide a SAFE mode.
- 498 The Instrument Safe mode is a combined Instrument hardware and software configuration meant
- 499 to protect the Instrument from possible internal or external harm while making minimal use of
- 500 Spacecraft resources (*e.g.* power).
- 501 4.2.4 Command (SAFE mode)
- The Instrument should enter SAFE mode when commanded either directly by the Host
- 503 Spacecraft or via ground operator command.

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- Rationale: The ability to put the Instrument into SAFE mode protects and preserves both the
- Instrument and the Host Spacecraft under anomalous and resource constrained conditions.
- 506 4.2.5 Command (Data Flow Control)
- The Instrument should respond to commands to suspend and resume the transmission of
- 508 Instrument telemetry and Instrument science data.
- Rationale: Data flow control allows the Spacecraft, Satellite Operator, and ground operations
- team to devise and operate Fault Detection Isolation, and Recovery (FDIR) procedures, crucial
- 511 for on-orbit operations.
- 512 4.2.6 Command (Acknowledgement)
- 513 The Instrument should acknowledge the receipt of all commands, in its telemetry.
- Rationale: Command acknowledgement allows the Spacecraft, Satellite Operator, and ground
- operations team to devise and operate FDIR procedures, crucial for on-orbit operations.
- 516 4.3 Data Accommodation Guidelines
- 517 4.3.1 Onboard Science Data Storage
- The Instrument should be responsible for its own science data onboard storage capabilities.
- Rationale: Buffering all data on the Instrument imposes no storage capacity requirements on the
- 520 Spacecraft. This is consistent with the direct-to-transponder science data interface [GEO]. A
- 521 spacecraft need only enough buffer capacity to relay Instrument telemetry. Fewer resource
- 522 impacts on the Spacecraft maximize Instrument hosting opportunities.

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523 5.0 ELECTRICAL POWER SYSTEM LEVEL 2 GUIDELINES

524 5.1 Assumptions

The CII electrical power guidelines assume the following regarding the Host Spacecraft:

- 1) During the matching process, the Host Spacecraft Manufacturer/Systems Integrator and the Instrument Developer will negotiate detailed parameters of the electrical power interface. The Electrical Power Interface Control Document (EICD) will record those parameters and decisions.
- 2) [LEO] The Host Spacecraft will supply to the Instrument EPS unregulated (sun regulated) electrical power within the range of 28 ±6 VDC, including ripple and normal transients as defined below, and power distribution losses due to switching, fusing, harness and connectors.
- 3) [GEO] The Host Spacecraft will supply to the Instrument EPS regulated electrical power within the range of 28 ±3 VDC, including ripple and normal transients as defined below, and power distribution losses due to switching, fusing, harness and connectors.
- 4) [LEO] The Host Spacecraft will provide connections to two 50W (Orbital Average Power: OAP) power buses as well as a dedicated bus to power the Instrument's survival heaters. Each bus will have a primary and redundant circuit. For the purpose of illustration, this document labels these buses as Power Bus #1, Power Bus #2, and Survival Heater Power Bus. This document also labels the primary and redundant circuits as A and B, respectively. Figure 5-1 shows a pictorial representation of this architecture.
- 5) [GEO] The Host Spacecraft will provide connections to two 150W (Average Power: AP) power buses as well as a dedicated bus to power the Instrument's survival heaters. Each power bus will be capable of supporting both primary and redundant power circuits. For the purpose of illustration, this document labels these buses as Power Bus #1, Power Bus #2, and Survival Heater Power Bus. This document also labels the primary and redundant circuits as A and B, respectively. Figure 5-1 shows a pictorial representation of this architecture.
- 6) The Host Spacecraft will energize the Survival Heater Power Bus at 30% of the OAP [LEO]/AP [GEO] in accordance with the mission timeline documented in the EICD.
- 7) The Host Spacecraft Manufacturer will supply a definition of the maximum source impedance by frequency band. Table 5-1 provides an example of this definition.
- 8) The Host Spacecraft Manufacturer will furnish all Spacecraft and Spacecraft-to-Instrument harnessing.
- 9) The Host Spacecraft will deliver Instrument power via twisted conductor (pair, quad, etc.) cables with both power and return leads enclosed by an electrical overshield.

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- 10) The Host Spacecraft will protect its own electrical power system via overcurrent protection devices on its side of the interface.
- 11) The Host Spacecraft will utilize the same type of overcurrent protection device, such as latching current limiters or fuses, for all connections to the Instrument.
- 12) In the event that the Host Spacecraft battery state-of-charge falls below 50%, the Host Spacecraft will power off the Instrument after placing the Instrument in SAFE mode. Instrument operations will not resume until the ground operators have determined it is safe to return to OPERATION mode.
- 13) The Host Spacecraft will deliver a maximum transient current on any Power Feed bus of 100 percent (that is, two times the steady state current) of the maximum steady-state current for no longer than 50 ms.

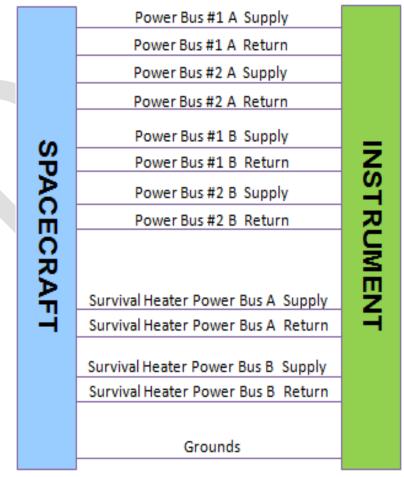


Figure 5-1: Spacecraft-Instrument Electrical Interface (Depicted with the optional Instrument side redundant Power Bus B interface)

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573 Table 5-1: Example of Power Source Impedance Function

Frequency	Maximum Source Impedance $[\Omega]$
1 Hz to 1 kHz	0.2
1 kHz to 20 kHz	1.0
20 kHz to 100 kHz	2.0
100 kHz to 10 MHz	20.0

574 5.2 EPS Interface

All guidelines in this section should be met at the electrical interface.

576 5.2.1 Power Bus Interface

The EPS should provide nominal power to each Instrument component via one or both of the Power Buses.

- Rationale: The Power Buses supply the electrical power for the Instrument to conduct normal operations. Depending on the load, a component may connect to one or both of the power buses.
- Note: The utilization of the redundant power circuits (Power Circuits B) by the Instrument is
- optional based upon instrument mission classification, reliability, and redundancy requirements.
- 583 5.2.2 Survival Heater Bus Interface
- The EPS should provide power to the survival heaters via the Survival Heater Power Bus.
- Rationale: The Survival Heaters, which are a member of the Thermal subsystem, require power
- to heat certain instrument components during off-nominal scenarios when the Power Buses are
- not fully energized. See Best Practices sections 9.2.3 and 9.4.2 for more discussion about
- 588 survival heaters.
- **589** 5.2.3 Grounding
- The Instrument grounding architecture should comply with NASA-HDBK-4001.
- Rationale: The Instrument grounding architecture must be established at the earliest point in the
- design process. The implementation of the subject level 1 guidance in conjunction with the
- consistent and proven design principles described in the ascribed reference will support a
- successful instrument development and integration to a Host Spacecraft and mission.
- 595 5.2.4 Grounding Documentation
- The EICD will document how the Instrument will ground to the Host Spacecraft.
- Rationale: It is necessary to define and document the Instrument to Host Spacecraft grounding
- 598 interface architecture.
- **599** 5.2.5 Bonding
- The Instrument bonding should comply with NASA-STD-4003.
- Rationale: The instrument bonding practices must be defined to support the instrument design
- and development process. The implementation of the subject reference will provide consistent

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- and proven design principles and support a successful instrument development, integration to a
- Host Spacecraft and mission.
- 605 5.2.6 Mitigation of In-Space Charging Effects
- The Instrument should comply with NASA-HDBK-4002 to mitigate in-space charging
- 607 effects.
- Rationale: The application of the defined reference to the Instrument grounding architecture and
- bonding practices will address issues and concerns with the in-flight buildup of charge on
- 610 internal spacecraft components and external surfaces related to space plasmas and high-energy
- electrons and the consequences of that charge buildup.
- 612 5.2.7 Instrument Harnessing
- 613 The Instrument Developer should furnish all Instrument harnessing.
- Rationale: The Instrument Developer is responsible for all harnesses that are constrained by the
- boundaries of the Instrument as a single and unique system. This refers only to those harnesses
- that are interconnections between components (internal and external) of the Instrument system
- and excludes any harnesses interfacing with the Host Spacecraft or components that are not part
- of the Instrument system.
- 619 5.2.8 Harness Documentation
- The EICD will document all harnesses, harness construction, pin-to-pin wiring, cable type,
- 621 connectors, ground straps, and associated service loops.
- Rationale: The EICD documents agreements made between the Host Spacecraft Manufacturer
- and Instrument Developer regarding harness hardware and construction.
- 624 5.3 EPS Accommodation
- This section specifies the characteristics, connections, and control of the Spacecraft power
- provided to each Instrument as well as the requirements that each Instrument must meet at this
- interface. This section applies equally to the Power Buses and the Survival Heater Power Buses.
- 628 5.3.1 Definitions
- Average Power Consumption: the total power consumed averaged over any 180-minute period.
- Peak Power Consumption: the maximum power consumed averaged over any 10 ms period.
- 5.3.2 Instrument Power Harness
- Instrument power harnesses should be sized to support the peak Instrument power level
- and both Host Spacecraft and Instrument overcurrent protection devices.
- Rationale: Sizing all components of the Instrument power harness, such as the wires,
- 635 connectors, sockets, and pins to the peak power level required by the Instrument and Host
- Spacecraft prevents damage to the power harnessing.

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637 5.3.3 Allocation of Instrument Power

The EPS should draw no more power from the Host Spacecraft in each Instrument mode

639 than defined in Table 5-2.

Rationale: The Level 1 guideline defines power allocation for the OPERATION mode. The

- assumption that the instrument requires 100% of the power required in the OPERATION mode
- defines the power allocation for the ACTIVATION mode. The assumption that the instrument
- requires 50% of the power required in the OPERATION mode defines the power allocation for the
- SAFE mode. The assumption that the instrument only requires survival heater power defines the
- power allocation for the SURVIVAL mode.
- Note: Instrument and Instrument survival heater power should not exceed the defined power
- allocation at end-of-life at worst-case low bus voltage.
- Note: The instrument modes are notional and based upon an example provided in Appendix G.

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Table 5-2: Instrument Power Allocation

Mode	LEO		GEO	
	Peak (W)	Average (W)	Average (W)	
OFF/ SURVIVAL	0/60	0/30	0/90	
ACTIVATION	200	100	300	
SAFE	100	50	150	
OPERATION	200	100	300	

650 5.3.4 Unannounced Removal of Power

The Instrument should function according to its operational specifications when nominal power is restored following an unannounced removal of power.

Rationale: In the event of a Host Spacecraft electrical malfunction, the instrument would likely

be one of the first electrical loads to be shed either in a controlled or uncontrolled manner.

655 5.3.5 Reversal of Power

The Instrument should function according to its operational specifications when proper polarity is restored following a reversal of power (positive) and ground (negative).

Rationale: This defines the ability of an instrument to survive a power reversal anomaly which

periodically occurs during assembly, integration, and test (AI&T).

660 5.3.6 <u>Power-Up and Power-Down</u>

The Instrument should function according to its operational specifications when the Host

Spacecraft changes the voltage across the Operational Bus from +28 to 0 VDC or from 0 to

+28 VDC as a step function.

Rationale: A necessary practice to preclude instrument damage/degradation.

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665	5.3.7	Abnormal	Operation	Steady	-State	Voltage	Limits

The Instrument should function according to its operational specifications when the Host Spacecraft restores nominal power following exposure to steady-state voltages from 0 to 50

668 VDC.

Rationale: Defines a verifiable (testable) limit for off-nominal input voltage testing of an

670 instrument.

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671 6.0 MECHANICAL LEVEL 2 GUIDELINES

672 6.1 **Assumptions**

- 673 The CII mechanical guidelines assume the following regarding the Host Spacecraft:
- 674 1) During the matching process, the Host Spacecraft Manufacturer/Systems Integrator and the Instrument Developer will negotiate detailed parameters of the mechanical interface. 675 The Mechanical Interface Control Document (MICD) will record those parameters and 676 677 decisions.
- 678 2) The Host Spacecraft will accommodate fields-of-view (FOV) that equal or exceed the 679 Instrument science and radiator requirements.
- 680 3) The Host Spacecraft Contractor will furnish all instrument mounting fasteners.

681 6.2 Mechanical Interface Guidelines

- 682 Functionality in 1 g Environment
- 683 The Instrument should function according to its operational specifications in any orientation while in the integration and test environment. 684
- 685 Rationale: As a hosted payload, the Instrument will attach to one of multiple decks on the Host
- 686 Spacecraft. Its orientation with respect to the Earth's gravitational field during integration and
- 687 test will not be known during the instrument design process. The function of the instrument and
- 688 accommodation of loads should not depend on being in a particular orientation.
- 689 6.2.2 **Stationary Instrument Mechanisms**
- The Instrument should cage any mechanisms that require restraint, without requiring Host 690
- Spacecraft power to maintain the caged condition, throughout the launch environment. 691
- 692 Rationale: As a hosted payload, the Instrument should not assume that the Host Spacecraft will
- 693 provide any power during launch.
- 694 6.3 Mechanical Accommodation Guidelines
- 695 6.3.1 **Dimensions**
- 696 [LEO] The Instrument and all of its components should remain within the detailed
- 697 instrument envelope of 400mm × 500mm× 850mm (H×W×L) during all phases of flight.
- 698 Rationale: Engineering analysis determined guideline payload volume based on mass guidelines
- 699 and comparisons to spacecraft envelopes in the NASA Rapid Spacecraft Development Office
- 700 (RSDO) catalog.
- 701 [GEO] The Instrument and all of its components should remain within the detailed
- 702 instrument envelope of 1000mm ×1000mm×1000mm (H×W×L) during all phases of flight.

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Rationale: Engineering analysis determined guideline payload volume based on mass guidelines and comparisons to spacecraft envelopes in responses to the *CII RFI for GEO Hosted Payload Opportunities and Accommodations*.

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706 7.0 THERMAL LEVEL 2 GUIDELINES

707 7.1 Assumptions

- 708 The CII thermal guidelines assume the following regarding the Host Spacecraft:
- 709 1) During the matching process, the Host Spacecraft Manufacturer/Systems Integrator and 710 the Instrument Developer will negotiate detailed parameters of the thermal power 711 interface. The Thermal Interface Control Document (TICD) will record those parameters 712 and decisions.
- 713 2) The Host Spacecraft will maintain a temperature range of between -40° C and 70°C on the Spacecraft side of the interface from the Integration through Disposal portions of its lifecycle.
- 716 3) The Spacecraft Manufacturer will be responsible for thermal hardware used to close out the interfaces between the Instrument and Spacecraft, such as closeout Multi-layer Insulation (MLI).

719 7.2 Thermal Interface

- 720 7.2.1 Thermal Design at the Mechanical Interface
- 721 The Instrument thermal design should be decoupled from the Spacecraft at the mechanical
- 722 interface spacecraft and neighboring payloads as much as possible.
- Rationale: As a hosted payload, the instrument should not interfere with the Host Spacecraft's
- functions. The common practice in the industry is to thermally isolate the payload from the
- 725 spacecraft.
- 726 7.2.2 Conductive Heat Transfer
- 727 The conductive heat transfer at the Instrument-Host Spacecraft mechanical interface
- 728 should be less than 15 W/m^2 or 4 W.
- Rationale: A conductive heat transfer of 15 W/m² or 4 W is considered small enough to meet the
- 730 intent of being thermally isolated.
- 731 7.2.3 Radiative Heat Transfer
- 732 The TICD will document the allowable radiative heat transfer from the Instrument to the
- 733 Host Spacecraft.
- Rationale: There is a limit to how much heat the Instrument should transmit to the Host
- 735 Spacecraft via radiation, but that limit will be unknown prior to the thermal analysis conducted
- 736 following Instrument-to-Host Spacecraft pairing. The TICD will document that future
- 737 negotiated value.
- 738 7.2.4 Temperature Maintenance Responsibility
- 739 The Instrument should maintain its own instrument temperature requirements.

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- Rationale: As a thermally isolated payload, the Instrument has to manage its own thermal
- 741 properties without support from the Host Spacecraft.
- 742 7.2.5 Instrument Allowable Temperatures
- 743 The TICD will document the allowable temperature ranges that the Instrument will
- 744 maintain in each operational mode/state.
- Rationale: Defining the instrument allowable temperatures drives the performance requirements
- 746 for the thermal management systems for both the Instrument as well as the Host Spacecraft.
- 747 7.2.6 Thermal Control Hardware Responsibility
- 748 The Instrument Provider should provide and install all Instrument thermal control
- hardware including blankets, temperature sensors, louvers, heat pipes, radiators, and
- 750 coatings.
- Rationale: This responsibility naturally follows the responsibility for the instrument thermal
- design and maintaining the temperature requirements of the instrument.

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753 8.0 ENVIRONMENTAL LEVEL 2 GUIDELINES

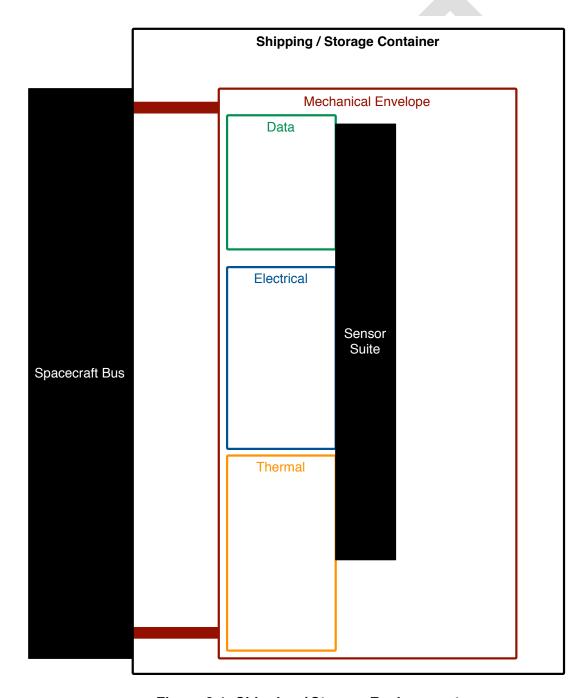
754 8.1 Assumptions

- The CII environmental guidelines assume the following regarding the Host Spacecraft, launch vehicle, and/or integration and test facilities:
- During the matching process, the Host Spacecraft Manufacturer/Systems Integrator and the Instrument Developer will negotiate detailed parameters of the environmental interface. The Environmental Interface Control Document (EICD) will record those parameters and decisions.
- Note: the design of the Instrument modes of operation are the responsibility of the Instrument Developer. For purposes of illustration, the operational modes in this section are equivalent to the Instrument modes and states as defined in Appendix G.

764 8.2 Shipping/Storage Environment

The Shipping/Storage Environment represents the time in the Instrument's lifecycle between when it departs the Instrument Developer's facility and arrives at the facility of the Spacecraft Manufacturer/Systems Integrator. The Instrument is dormant and attached mechanically to its container (see Figure 8-1).

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Figure 8-1: Shipping / Storage Environment

8.2.1 Documentation

The EICD will document the expected environment the Instrument will experience between the departure from the Instrument assembly facility and arrival at the Host Spacecraft integration facility.

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- Rationale: The nature of the Shipping/Storage Environment depends upon the point at which
- physical custody of the Instrument transfers from Instrument Developer to the Satellite
- 777 Contractor/Systems Integrator as well as negotiated agreements on shipping/storage procedures.
- 778 The interfaces associated with the shipping/storage environment include the allowable
- temperatures and the characteristics of the associated atmosphere.
- 780 8.2.2 Instrument Configuration
- 781 The EICD will document the configuration and operational state of the Instrument during
- 782 the Shipping/Storage phase.
- Rationale: Specifying the configuration of the Instrument during shipping/storage drives the
- volume requirements for the container as well as any associated support equipment and required
- 785 services.
- 786 The Instrument will likely be in the OFF/SURVIVAL mode while in this environment.
- 787 8.3 Integration and Test Environment
- The Integration and Test Environment represents the time in the Instrument's lifecycle between
- when it arrives at the facility of the Spacecraft Manufacturer/Systems Integrator through payload
- 790 encapsulation at the launch facility. During this phase, the Host Spacecraft
- 791 Manufacturer/Systems Integration will attach the Instrument to the Host Spacecraft Bus and
- verify that system performs as designed throughout various environmental and dynamics
- 793 regimes. The Instrument may be attached to the Host Spacecraft Bus or to various ground
- support equipment that transmits power, thermal conditioning, and diagnostic data (see Figure
- 795 8-2).

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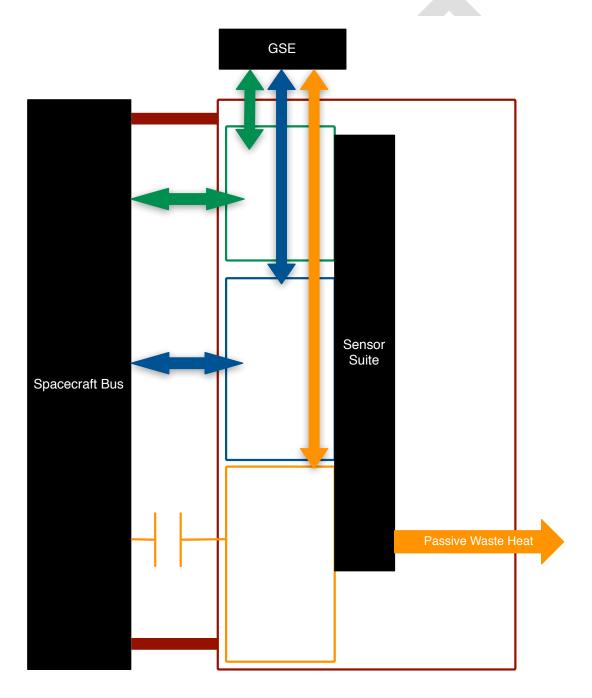


Figure 8-2: Integration and Test Environment

8.3.1 Documentation

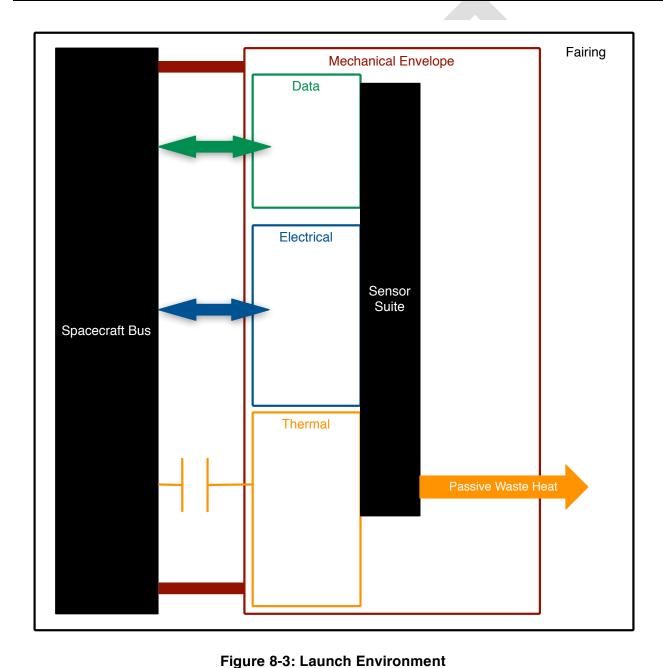
The EICD will document the expected environments the Instrument will experience between arrival at the Host Spacecraft integration facility and Launch.

Rationale: The nature of the Integration and Test Environment depends upon the choice of Host Spacecraft and Launch Vehicle as well as the negotiated workflows at the Systems Integration and Launch facilities.

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- Example environmental properties include the thermal, dynamic, atmospheric, electromagnetic, radiation characteristics of each procedure in the Integration and Test process. The EICD may either record these data explicitly or refer to a negotiated Test and Evaluation Master Plan (TEMP).
- 808 8.3.2 Instrument Configuration
- The EICD will document the configuration and operational mode of the Instrument during the Integration and Test phase.
- Rationale: Proper configuration of the Instrument during the various Integration and Test procedures ensures the validity of the process.
- 813 8.4 Launch Environment
- The Launch Environment represents that time in the Instrument's lifecycle when it is attached to
- the launch vehicle via the Host Spacecraft, from payload encapsulation at the Launch facility
- 816 through the completion of the launch vehicle's final injection burn (see Figure 8-3).

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823 824 8.4.1 Documentation

The EICD will document the expected environments the Instrument will experience between Launch and Host Spacecraft / Launch Vehicle separation.

Rationale: The nature of the Launch Environment depends upon the choice of Host Spacecraft and Launch Vehicle. Significant parameters related to the launch environment include temperature, pressure, and acceleration profiles.

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- 825 8.4.2 Instrument Configuration
- The EICD will document the configuration and operational state of the Instrument during the Launch phase.
- Rationale: The Launch phase is the most dynamic portion of the mission, and the Instrument
- 829 configuration and operational mode are chosen to minimize damage to either the Instrument or
- 830 Host Spacecraft. The Instrument will likely be in the OFF/SURVIVAL mode while in this
- 831 environment.
- The following guidelines are representative of a typical launch environment but may be tailored
- on a case-by-case basis.
- 834 8.4.3 Launch Pressure Profile
- The Instrument should function according to its operational specifications after being
- 836 subjected to an atmospheric pressure decay rate of 7 kPa/s (53 Torr/s).
- Rationale: The Instrument must be able to withstand conditions typical of the AI&T, launch and
- 838 on-orbit environments without suffering degraded performance or being damaged or inducing
- degraded performance of, or damage to, the Host Spacecraft or other payloads. This guidance
- represents the maximum expected pressure decay rate during launch ascent and applies to LEO
- and GEO launch vehicles. The GEO guideline is the all-satisfy strategy scenario, based upon CII
- analysis of the following sources of performance data: CII RFI for GEO Hosted Payload
- 843 Opportunities responses, the General Environmental Verification Specification for STS & ELV
- 844 Payloads, Subsystems, and Components (GEVS-SE), and Geostationary Operational
- 845 Environmental Satellite GOES-R Series General Interface Requirements Document (GOES-R
- 846 *GIRD*).

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- 847 8.4.4 Ouasi-Static Acceleration
- 848 [GEO] The Instrument should function according to its operational specifications after
- being subjected to a launch vehicle-induced quasi-static acceleration environment
- represented by the MAC defined in Table 8-1.

Table 8-1: [GEO] Mass Acceleration Curve

Mass [kg]	Acceleration [g]
0 to 2.5	± 55
2.5 to 30	$= \pm (-1.273 \times Mass + 58.182)$
>30	± 20

Rationale: The Instrument must able to withstand conditions typical of the AI&T, launch and onorbit environment without suffering degraded performance or being damaged or inducing degraded performance of or damage to the spacecraft host or other payloads. This guidance represents the need to be compatible with the quasi-static loads that will be experienced during launch ascent. The GEO guideline is the all-satisfy strategy scenario, based upon CII analysis of the following sources of performance data: CII RFI for GEO Hosted Payload Opportunities responses, the GEVS-SE, and GOES-R GIRD.

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The "Mass" is the mass of the entire instrument or any component of the instrument. The MAC applies to the worst-case single direction, which might not be aligned with coordinate directions, to produce the greatest load component (axial load, bending moment, reaction component, stress level, etc.) being investigated and also to the two remaining orthogonal directions.

8.4.5 Sinusoidal Vibration

The Instrument should function according to its operational specifications after being subjected to a launch vehicle-induced transient environment represented by the sinusoidal vibration environment defined in Table 8-2.

Table 8-2: Sinusoidal Vibration Environment

Frequency (Hz)	Acceleration Amplitudes	
	Acceptance	Qualification
2-5	1.0 g peak	1.4 g peak
5 – 18	1.4 g peak	2.0 g peak
18 – 30	1.5 g peak	2.1 g peak
30 – 40	1.0 g peak	1.4 g peak
40 – 55	3.0 g peak	4.2 g peak
55 – 100	1.0 g peak	1.4 g peak
Accontance Sween Date: From 5 to 10	00 Hz at 1.0 octaves/minute except from	40 to 55 Hz at 10 Hz/min

Acceptance Sweep Rate: From 5 to 100 Hz at 1.0 octaves/minute except from 40 to 55 Hz at 12 Hz/min Qualification Sweep Rate: From 5 to 100 Hz at 0.5 octaves/minute except from 40 to 55 Hz at 6 Hz/min

Rationale: The Instrument must be able to withstand conditions typical of the AI&T, launch and on-orbit environment without suffering degraded performance or being damaged or inducing degraded performance of or damage to the spacecraft host or other payloads. This guidance represents the need to be compatible with the coupled dynamics loads that will be experienced during ground processing and launch ascent. The GEO guideline is the all-satisfy strategy scenario, based upon CII analysis of all publicly available launch vehicle payload planner's guides.

8.4.6 Random Vibration

[LEO] The Instrument should function according to its operational specifications after being subjected to a launch vehicle-induced transient environment represented by the random vibration environment defined in Table 8-3.

All flight article test durations are to be 1 minute per axis. Non-flight article qualification test durations are to be 2 minutes per axis.

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Table 8-3: [LEO] Random Vibration Environment (derived from GEVS-SE, Table 2.4-4)

Zone/Assembly	Frequency (Hz)	Protoflight / Qualification	Acceptance
Instrument	20	0.026 g ² /Hz	0.013 g ² /Hz
	20 – 50	+6 dB/octave	+6 dB/octave
	50 - 800	0.16 g ² /Hz	0.08 g ² /Hz
	800 - 2000	-6 dB/octave	-6 dB/octave
	2000	0.026 g ² /Hz	0.013 g ² /Hz
	Overall	14.1 g _{rms}	10.0 g _{rms}

Table 8-3 represents the random vibration environment for instruments with mass less than or equal to 25 kg. Instruments with mass greater than 25 kg may apply the following random vibration environment reductions:

1) The acceleration spectral density (ASD) level may be reduced for components weighing more than 25 kg according to:

$$ASD_{new} = ASD_{original}*(25/M)$$

where $M = \text{instrument mass in kg}$

2) The slope is to be maintained at ± 6 dB/octave for instruments with mass less than or equal to 65 kg. For instruments greater than 65 kg, the slope should be adjusted to maintain an ASD of 0.01 g²/Hz at 20 Hz and at 2000 Hz for qualification testing and an ASD of 0.005 g²/Hz at 20 Hz and at 2000 Hz for acceptance testing.

[GEO] The Instrument should function according to its operational specifications after being subjected to a launch vehicle-induced transient environment represented by the random vibration environment defined in Table 8-4.

All flight article test durations are to be 1 minute per axis. Protoflight and non-flight article qualification test durations are to be 3 minutes per axis.

Table 8-4: [GEO] Random Vibration Environment

Zone/Assembly	Frequency (Hz)	Protoflight / Qualification	Acceptance
Instrument	20	0.2 g ² /Hz	0.14 g²/Hz
	20 - 45	+6 dB/octave	+6 dB/octave
	45 - 500	1.0 g ² /Hz	0.71 g²/Hz
	500 - 2000	-6 dB/octave	-6 dB/octave
	2000	0.06 g ² /Hz	0.04 g ² /Hz
	Overall	28.9 g _{rms}	24.2 g _{rms}

Table 8-4 represents the random vibration environment for all instruments

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Rationale: The Instrument must able to withstand conditions typical of the AI&T, launch and on-orbit environment without suffering degraded performance or being damaged or inducing degraded performance of or damage to the spacecraft host or other payloads. This guidance represents the need to be compatible with the random vibration that will be experienced during launch ascent. The random vibration design guidelines are derived from: (a) launch vehicle-induced acoustic excitations during liftoff, transonic and max-q events; and (b) mechanically transmitted vibration from the engines during upper stage burns. The guidelines are the all-satisfy strategy scenario, based upon CII analysis of the following sources of performance data: *CII RFI for GEO Hosted Payload Opportunities* responses (GEO only), the *GEVS-SE* (LEO and GEO), and *GOES-R GIRD* (GEO only).

910 8.4.7 Acoustic Noise

The Instrument should function according to its operational specifications after being subjected to a launch vehicle-induced transient environment represented by the acoustic noise spectra defined in Table 8-5.

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Table 8-5: Acoustic Noise Environment

1/3 Octave Band Center Frequency (Hz)"	Design/Qual/Protoflight (dB w/ 20 μPa reference)"	Acceptance (dB w/ 20 μPa reference)"
25	128.23	125.23
31.5	132	129
40	133.5	130.5
50	134	131
63	135	132
80	136.6	133.6
100	137.4	134.4
125	136.3	133.3
160	137.1	134.1
200	137.23	134.23
250	138.2	135.2
315	139	136
400	137.5	134.5
500	134.23	131.23
630	134.23	131.23
800	131.5	128.5
1000	129.23	126.23
1250	129.23	126.23
1600	124.8	121.8
2000	125	122
2500	124.23	121.23
3150	121.5	118.5
4000	120	117
5000	120	117
6300	118	115
8000	118	115
10000	119	116

Rationale: Acoustic design guidelines are based on maximum internal payload fairing sound pressure level spectra. The Instrument must be able to withstand conditions typical of the AI&T, launch and on-orbit environment without suffering degraded performance or being damaged or inducing degraded performance of or damage to the spacecraft host or other payloads. This guidance represents the need to be compatible with the acoustic noise that will be experienced during launch ascent. The guideline is the all-satisfy strategy scenario, based upon CII analysis of the following sources of performance data: *CII RFI for GEO Hosted Payload Opportunities* responses, all publically available launch vehicle Payload Planers Guides (with the exception of the Long March LV) and the *GOES-R GIRD*.

The acoustic noise design requirement for both the instrument and its assemblies is a reverberant random-incidence acoustic field specified in 1/3 octave bands. The design / qualification / protoflight exposure time is 2 minutes; acceptance exposure time is one minute.

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928 8.4.8 Mechanical Shock

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[GEO] The Instrument should function according to its operational specifications after being subjected to a spacecraft to launch vehicle separation or other shock transient accelerations represented by Table 8-6.

Table 8-6: [GEO] Mechanical Shock Environment

Frequency [Hz]	Acceleration [g]
100	115.1
600	2000
2000	5000
10000	5000

Rationale: The Instrument must able to withstand conditions typical of the AI&T, launch and onorbit environment without suffering degraded performance or being damaged or inducing degraded performance of or damage to the spacecraft host or other payloads. This guidance represents the need to be compatible with the mechanical shock that will be experienced during ground processing, launch ascent and on orbit. The GEO guideline is the all-satisfy strategy scenario, based upon CII analysis of the following sources of performance data: *CII RFI for GEO Hosted Payload Opportunities* responses, NASA GEVS and the GOES R GIRD. A quality factor (Q) of 10 is a typical value for a pyrotechnic separation system shock event. This value may be tailored based upon the shock environments anticipated/defined following the pairing of the Instrument and Host Spacecraft.

8.5 **Operational Environment**

The Operational Environment represents that time in the Instrument's lifecycle following the completion of the launch vehicle's final injection burn, when the Instrument is exposed to space and established in its operational orbit (Figure 8-4).

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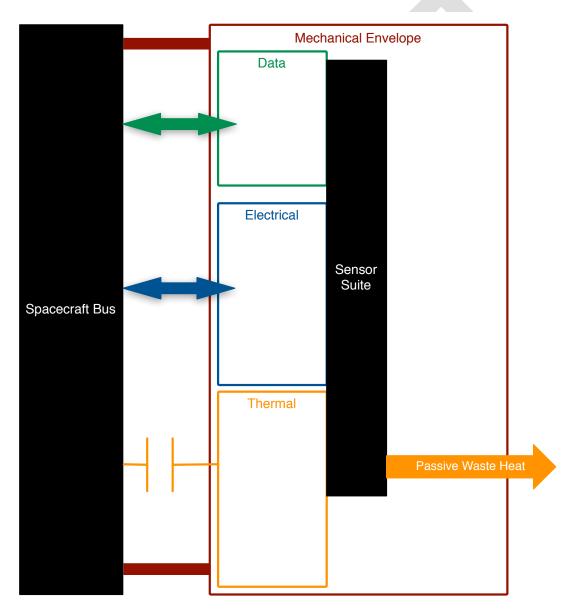


Figure 8-4: Operational Environment

Unless otherwise stated, the LEO guidelines are based upon a 98 degree inclination, 705 km altitude circular orbit. The GEO guidelines are based upon a zero degree inclination, 35786 km altitude circular orbit.

8.5.1 Orbital Acceleration

The Instrument should function according to its operational specifications after being subjected to a maximum spacecraft-induced acceleration of 0.04g.

Rationale: The Instrument in its operational configuration must able to withstand conditions typical of the on-orbit environment without suffering degraded performance or being damaged or inducing degraded performance of or damage to the Host Spacecraft or other payloads. This

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guidance represents the need to be compatible with the accelerations that will be experienced on orbit. The guideline is the all-satisfy strategy scenario, based upon CII analysis of the following sources of performance data: *CII RFI for GEO Hosted Payload Opportunities* responses, the *GEVS-SE*. and *GOES-R GIRD*.

8.5.2 Corona

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The Instrument should exhibit no effect of corona or other forms of electrical breakdown after being subjected to a range of ambient pressures from 101 kPa (\sim 760 Torr) at sea level to 1.3×10^{-15} kPa (10^{-14} Torr) in space.

Rationale: The Instrument must be able to withstand conditions typical of the AI&T, launch and on-orbit environment without suffering degraded performance or being damaged or inducing degraded performance of or damage to the spacecraft host or other payloads. This guidance represents the need to be compatible with the environment that will be experienced during ground processing, launch ascent and on orbit. The guideline is the all-satisfy strategy scenario, based upon CII analysis of the following sources of performance data: *CII RFI for GEO Hosted Payload Opportunities* responses, the *GEVS-SE*, and *GOES-R GIRD*.

973 8.5.3 Thermal Environment

The Instrument should function according to its operational specifications after being subjected to a thermal environment characterized by Table 8-7.

Table 8-7: Thermal Radiation Environment

Domain	Solar Flux [W/m ²]	Earth IR (Long Wave) [W/m ²]	Earth Albedo
LEO	1000 to 1400	222 to 243	0.275 to 0.375
GEO	1290 to 1420	Insignificant	Insignificant

977 Rationale: The Instrument must be able to withstand conditions typical of the on-orbit 978 environment without suffering degraded performance or being damaged or inducing degraded 979 performance of or damage to the spacecraft host or other payloads. While the Earth albedo and 980 long wave infrared radiation are non-zero values at GEO, their contribution to the overall 981 thermal environment is less than 0.05% of that from solar flux.

982 8.5.4 Radiation Design Margin

Every hardware component of the Instrument should have a minimum RDM value of two.

Rationale: Exposure to radiation degrades many materials and will require mitigation to assure full instrument function over the design mission lifetime. This guidance defines the need to carry 100% margin against the estimated amount of radiation exposure that will be experienced in Earth orbit in support of said mitigation.

A Radiation Design Margin (RDM) for a given electronic part (with respect to a given radiation environment) is defined as the ratio of that part's capability (with respect to that environment and its circuit application) to the environment level at the part's location.

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991 8.5.5 Total Ionizing Dose

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The Instrument should function according to its operational specifications during and after exposure to the Total Ionizing Dose (TID) radiation environment based upon the specified mission orbit over the specified mission lifetime.

Table 8-8 shows the expected total ionizing dose for object in a 813 km, sun-synchronous orbit, for over the span of two years, while shielded by an aluminum spherical shell of a given thickness. Figure 8-5 plots the same data in graphical form. The data contain no margin or uncertainty factors.

Table 8-8: [LEO] Total lonizing Dose Radiation Environment

Shield	Trapped		Trapped	Solar	
Thickness	Electrons	Bremsstrahlung	Protons	Protons	Total
[mil]	Rad [Si]	Rad [Si]	Rad [Si]	Rad [Si]	Rad [Si]
1	1.09E+06	1.84E+03	5.24E+04	6.52E+04	1.21E+06
3	5.23E+05	1.03E+03	1.70E+04	2.81E+04	5.69E+05
4	3.99E+05	8.30E+02	1.29E+04	2.18E+04	4.35E+05
6	2.44E+05	5.70E+02	8.86E+03	1.48E+04	2.68E+05
7	1.98E+05	4.87E+02	7.70E+03	1.29E+04	2.19E+05
9	1.38E+05	3.72E+02	6.30E+03	1.04E+04	1.55E+05
10	1.18E+05	3.32E+02	5.79E+03	9.47E+03	1.34E+05
12	9.04E+04	2.70E+02	5.01E+03	7.92E+03	1.04E+05
13	8.03E+04	2.46E+02	4.72E+03	7.31E+03	9.25E+04
15	6.45E+04	2.08E+02	4.28E+03	6.28E+03	7.53E+04
29	2.31E+04	9.80E+01	2.80E+03	2.96E+03	2.90E+04
44	1.23E+04	6.33E+01	2.18E+03	1.94E+03	1.65E+04
58	7.93E+03	4.75E+01	1.89E+03	1.47E+03	1.13E+04
73	5.24E+03	3.71E+01	1.70E+03	1.14E+03	8.12E+03
87	3.66E+03	3.06E+01	1.57E+03	9.30E+02	6.19E+03
117	1.81E+03	2.22E+01	1.39E+03	6.40E+02	3.86E+03
146	9.59E+02	1.76E+01	1.28E+03	4.52E+02	2.71E+03
182	4.38E+02	1.40E+01	1.19E+03	3.13E+02	1.95E+03
219	1.90E+02	1.17E+01	1.12E+03	2.47E+02	1.56E+03
255	8.38E+01	1.01E+01	1.06E+03	2.20E+02	1.38E+03
292	3.55E+01	8.97E+00	1.02E+03	1.98E+02	1.26E+03
365	5.72E+00	7.43E+00	9.34E+02	1.61E+02	1.11E+03
437	6.98E-01	6.46E+00	8.76E+02	1.38E+02	1.02E+03
510	4.96E-02	5.77E+00	8.32E+02	1.22E+02	9.60E+02
583	7.76E-04	5.26E+00	7.77E+02	1.05E+02	8.87E+02
656	1.06E-05	4.85E+00	7.38E+02	9.35E+01	8.36E+02
729	1.37E-07	4.49E+00	7.06E+02	8.50E+01	7.95E+02
875	0.00E+00	3.92E+00	6.42E+02	7.02E+01	7.16E+02
1167	0.00E+00	3.14E+00	5.42E+02	5.09E+01	5.96E+02
1458	0.00E+00	2.61E+00	4.67E+02	3.90E+01	5.09E+02

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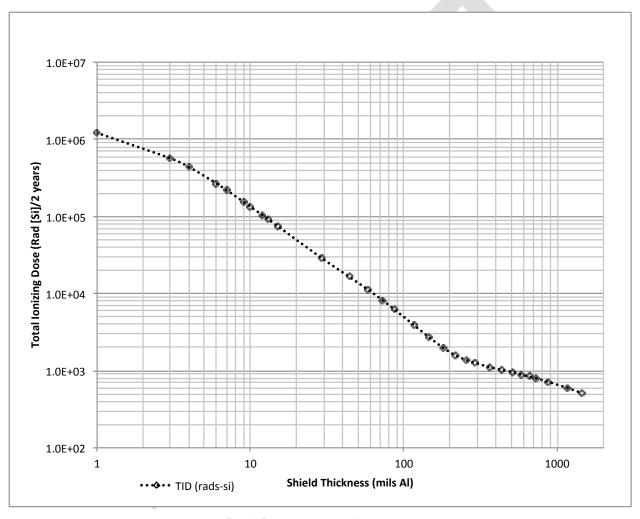


Figure 8-5: [LEO] TID versus Shielding Thickness

Table 8-9 shows the expected total ionizing dose for object in GEO, over the span of two years, while shielded by an aluminum spherical shell of a given thickness. Figure 8-6 plots the same data. The data contain no margin or uncertainty factors.

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Table 8-9: [GEO] Total Ionizing Dose Radiation Environment

Aluminum Shield Thickness [mil]	Total Dose [Rad]-Si	
0	2.09E+08	
10	2.62E+07	
20	9.64E+06	
30	4.78E+06	
40	2.70E+06	
50	1.60E+06	
60	1.01E+06	
70	6.60E+05	
80	4.44E+05	
90	3.19E+05	
100	2.31E+05	
110	1.69E+05	
120	1.26E+05	
130	9.37E+04	
140	6.67E+04	
150	5.26E+04	
160	3.94E+04	
170	2.87E+04	
180	2.36E+04	
190	1.88E+04	
200	1.43E+04	
210	1.17E+04	
220	1.01E+04	
230	8.57E+03	
240	7.10E+03	
250	5.96E+03	
260	5.28E+03	
270	4.63E+03	
280	4.01E+03	
290	3.41E+03	
300	2.90E+03	

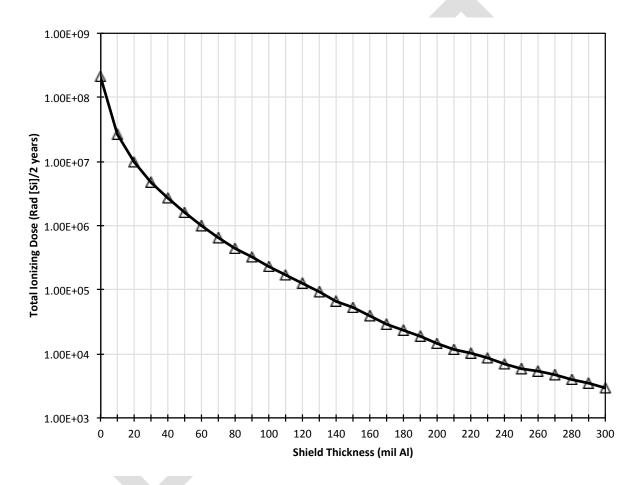


Figure 8-6: [GEO] TID versus Shielding Thickness

Rationale: Exposure to ionizing radiation degrades many materials and electronics in particular, and will require mitigation to ensure full instrument function over the design mission lifetime. Mitigation is typically achieved through application of the appropriate thickness of shielding. The LEO TID radiation environment is representative of exposure at an 813 km, sunsynchronous orbit. Analysis of dose absorption through shielding is based upon the SHIELDOSE2 model, which leverages NASA's Radiation Belt Models, AE-8 and AP-8, and JPL's Solar Proton Fluence Model. The GEO guideline is the all-satisfy strategy scenario, based upon CII analysis of the following sources of performance data: *CII RFI for GEO Hosted Payload Opportunities* responses and *The Radiation Model for Electronic Devices on GOES-R Series Spacecraft* (417-R-RPT-0027). The TID accrues as a constant rate and may be scaled for shorter and longer mission durations.

The LEO data represent conservative conditions for a specific orbit. While these data may envelop the TID environment of other LEO mission orbits (particularly those of lower altitude and inclination), Instrument Developers should analyze the TID environment for their Instrument's specific orbit. Since TID environments are nearly equivalent within the GEO domain, these data likely envelop the expected TID environment for GEO Earth Science

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1026 missions. The same caveat regarding Instrument Developer analysis of the TID environment

also applies to the GEO domain. 1027

1028 8.5.6 [GEO] Instrument Interference

1029 The Instrument should function according to specification in the operational environment 1030

when exposed to the particle fluxes defined by Table 8-10.

1031 Rationale: The particle background causes increased noise levels in instruments and other

1032 electronics. No long term flux is included for solar particle events because of their short

1033 durations. This guidance is based upon "Long-term and worst-case particle fluxes in GEO

1034 behind 100 mils of aluminum shielding", Table 4 of 417-R-RPT-0027.

Table 8-10: [GEO] Particle fluxes in GEO w/ 100 mils of Aluminum Shielding

Radiation:	Long-term flux [#/cm²/s]	Worst-case flux [#/cm²/s]
Galactic Cosmic Rays	2.5	4.6
Trapped Electrons	6.7×10^4	1.3×10^6
Solar Particle Events		2.0×10^{5}

1036 8.5.7 Micrometeoroids

The Instrument Developer should perform a probability analysis to determine the type and

amount of shielding to mitigate the fluence of micrometeoroids in the expected mission

1039 orbit over the primary mission.

1040 Table 8-11 and Figure 8-7 provide a conservative micrometeoroid flux environment for both

1041 LEO and GEO.

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1042 Rationale: Impacts from micrometeoroids may cause permanently degraded performance or

damage to the hosted payload instrument. This guidance provides estimates of the worst-case 1043

scenarios of micrometeoroid particle size and associated flux over the LEO and GEO domains. 1044

1045 The data come from the Grün flux model assuming a meteoroid mean speed of 20 km/s. Of note,

1046 the most hazardous micrometeoroid environment in LEO is at an altitude of 2000 km. If a less

1047 conservative LEO environment is desired, the Instrument Developer should perform an analysis

1048 tailored to the risk tolerance.

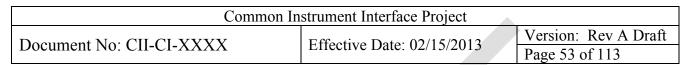
1049 Micrometeoroid and artificial space debris flux guidelines are separate due to the stability of

1050 micrometeoroid flux over time, compared to the increase of artificial space debris.

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Table 8-11: Worst-case Micrometeoroid Environment

		Flux (particles/m²/year]	
Particle mass [g]	Particle diameter [cm]	LEO	GEO
1.00E-18	9.14E-07	1.20E+07	9.53E+06
1.00E-17	1.97E-06	1.75E+06	1.39E+06
1.00E-16	4.24E-06	2.71E+05	2.15E+05
1.00E-15	9.14E-06	4.87E+04	3.85E+04
1.00E-14	1.97E-05	1.15E+04	9.14E+03
1.00E-13	4.24E-05	3.80E+03	3.01E+03
1.00E-12	9.14E-05	1.58E+03	1.25E+03
1.00E-11	1.97E-04	6.83E+02	5.40E+02
1.00E-10	4.24E-04	2.92E+02	2.31E+02
1.00E-09	9.14E-04	1.38E+02	1.09E+02
1.00E-08	1.97E-03	5.41E+01	4.28E+01
1.00E-07	4.24E-03	1.38E+01	1.09E+01
1.00E-06	9.14E-03	2.16E+00	1.71E+00
1.00E-05	1.97E-02	2.12E-01	1.68E-01
1.00E-04	4.24E-02	1.50E-02	1.19E-02
1.00E-03	9.14E-02	8.65E-04	6.84E-04
1.00E-02	1.97E-01	4.45E-05	3.52E-05
1.00E-01	4.24E-01	2.16E-06	1.71E-06
1.00E+00	9.14E-01	1.02E-07	8.05E-08
1.00E+01	1.97E+00	4.72E-09	3.73E-09
1.00E+02	4.24E+00	2.17E-10	1.72E-10



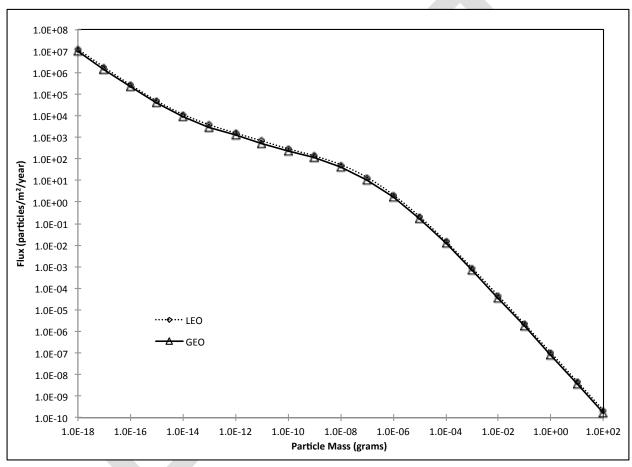


Figure 8-7: Worst-case Micrometeoroid Environment

8.5.8 Artificial Space Debris

The Instrument Developer should perform a probability analysis to determine the type and amount of shielding to mitigate the fluence of artificial space debris in the expected mission orbit over the primary mission.

Table 8-12, Figure 8-8, Table 8-13, and Figure 8-9 provide conservative artificial space debris flux environments for both LEO and GEO.

Table 8-12: [LEO] Worst-case Artificial Space Debris Environment

Object Size [m]	Flux [objects/m²/year]	Object Velocity [km/s]
1.00E-05	4.14E+03	12.02
1.00E-04	4.10E+02	9.25
1.00E-03	3.43E-01	10.63
1.00E-02	1.50E-04	10.53
1.00E-01	6.64E-06	9.10
1.00E+00	2.80E-06	9.34
	Average Velocity:	10.15

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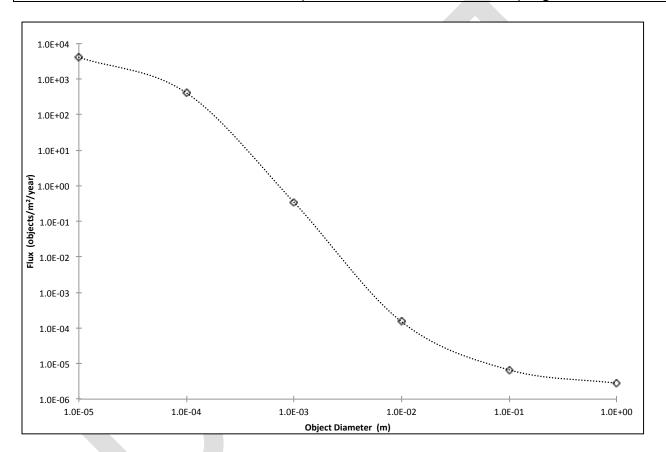


Figure 8-8: [LEO]: Worst-case Artificial Space Debris Environment

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Table 8-13: [GEO] Worst-case Artificial Space Debris Environment

Object	Flux	Object	Flux	Object	Flux
Diameter [m]	[objects/m²/year]	Diameter [m]	[objects/m²/year]	Diameter [m]	[objects/m²/year]
1.00000E-03	2.08800E-05	2.06200E-02	1.56300E-08	4.25179E-01	3.93000E-09
1.14100E-03	1.58800E-05	2.35200E-02	1.40200E-08	4.84969E-01	3.89700E-09
1.30100E-03	9.74700E-06	2.68270E-02	1.13500E-08	5.53168E-01	3.85700E-09
1.48400E-03	6.06200E-06	3.05990E-02	1.02900E-08	6.30957E-01	3.83000E-09
1.69300E-03	4.70300E-06	3.49030E-02	9.74100E-09	7.19686E-01	3.81700E-09
1.93100E-03	3.38900E-06	3.98110E-02	8.92500E-09	8.20891E-01	3.76600E-09
2.20200E-03	2.32700E-06	4.54090E-02	8.07400E-09	9.36329E-01	3.75200E-09
2.51200E-03	1.55700E-06	5.17950E-02	7.06300E-09	1.06800E+00	3.73800E-09
2.86500E-03	1.10200E-06	5.90780E-02	6.36200E-09	1.21819E+00	3.73800E-09
3.26800E-03	7.81600E-07	6.73860E-02	5.88900E-09	1.38949E+00	3.73800E-09
3.72800E-03	5.16800E-07	7.68620E-02	5.52200E-09	1.58489E+00	3.73800E-09
4.25200E-03	3.73600E-07	8.76710E-02	5.30700E-09	1.80777E+00	3.73800E-09
4.85000E-03	2.88600E-07	1.00000E-01	4.91200E-09	2.06199E+00	3.38500E-09
5.53200E-03	2.15600E-07	1.14062E-01	4.66500E-09	2.35195E+00	3.38500E-09
6.31000E-03	1.60200E-07	1.30103E-01	4.56000E-09	2.68270E+00	3.38500E-09
7.19700E-03	1.20300E-07	1.48398E-01	4.39400E-09	3.05995E+00	3.38000E-09
8.20900E-03	8.21500E-08	1.69267E-01	4.27400E-09	3.49025E+00	3.37800E-09
9.36300E-03	6.42500E-08	1.93070E-01	4.18300E-09	3.98107E+00	1.95200E-09
1.06800E-02	5.00200E-08	2.20220E-01	4.14700E-09	4.54091E+00	1.95000E-09
1.21820E-02	4.05400E-08	2.51189E-01	4.08200E-09	5.17948E+00	1.94900E-09
1.38950E-02	3.00300E-08	2.86512E-01	4.02900E-09	5.90784E+00	1.94800E-09
1.58490E-02	2.36300E-08	3.26803E-01	3.99300E-09	6.73863E+00	1.94800E-09
1.80780E-02	1.92000E-08	3.72759E-01	3.96000E-09	7.68625E+00	1.36900E-13
			Average	Velocity (km/s)	1.3333

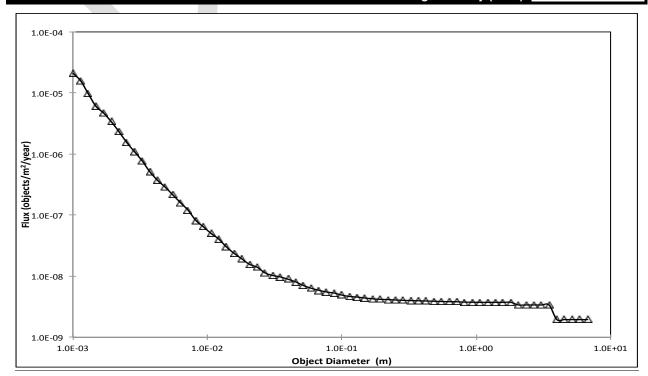


Figure 8-9: [GEO] Worst-case Artificial Space Debris Environment

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1067 1068 1069 1070 1071	Rationale: Impacts from artificial space debris may permanently degrade performance or damage the Instrument. This guidance estimates the maximum artificial space debris flux and impact velocities an Instrument can expect to experience for both LEO and GEO domains during the Calendar Year 2015 epoch. Expected artificial space debris flux increases over time as more hardware is launched into orbit.
1072 1073 1074	The LEO analysis covers altitudes from 200 to 2000 km and orbital inclinations between 0 and 180 degrees. The ORDEM2000 model, developed by the NASA Orbital Debris Program Office at Johnson Space Center, is the source of the data.
1075 1076 1077	Based upon analysis of ESA's 2009 MASTER (Meteoroid and Space Debris Environment) model, the GEO guidance aggregates the maximum expected artificial space debris flux, sampled at 20° intervals around the GEO belt.
1078 1079	Micrometeoroid and artificial space debris flux guidelines are listed separately due to the stability of micrometeoroid flux over time, compared to the increase of artificial space debris.
1080 1081 1082 1083	8.5.9 Atomic Oxygen Environment The Instrument should function according to its specifications following exposure to the atomic oxygen environment, based on its expected mission orbit, for the duration of the Instrument primary mission.
1084 1085 1086 1087 1088 1089	Rationale: Exposure to atomic oxygen degrades many materials and requires mitigation to ensure full Instrument function over the design mission lifetime. Atomic oxygen levels in LEO are significant and may be derived using the Figure 8-10, which estimates the atomic oxygen flux, assuming an orbital velocity of 8 km/sec, for a range of LEO altitudes over the solar cycle inclusive of the standard atmosphere. Atomic oxygen levels in GEO are negligible and are only significant for GEO-bound Instruments that spend extended times in LEO prior to GEO transfer.

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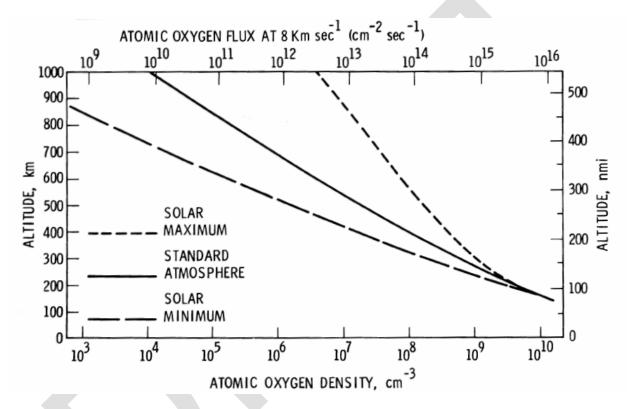


Figure 8-10: Atmospheric Atomic Oxygen density in Low Earth Orbit (Figure 2 from de Rooij 2000)

8.5.10 <u>Electromagnetic Interference & Compatibility Environment</u>

The Instrument should function according to its specification following exposure to the Electromagnetic Interference and Electromagnetic Compatibility (EMI/EMC) environments as defined in the applicable sections of MIL-STD-461.

 Please note that the environments defined in MIL-STD-461 may be tailored in accordance with the Host Spacecraft, launch vehicle and launch range requirements.

Rationale: Exposure of the hosted payload instrument to electromagnetic fields may induce degraded performance or damage in the instrument electrical and/or electronic subsystems. The application of the appropriate environments as described in the above noted reference and in accordance with those test procedures defined in, or superior to, MIL-STD-461 or MIL-STD-462, will result in an instrument that is designed and verified to assure full instrument function in the defined EMI/EMC environments.

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1105 9.0 REFERENCE MATERIAL / BEST PRACTICES

- 1106 9.1 Data Interface Reference Material / Best Practices
- 1107 9.1.1 CCSDS Data Transmission
- 1108 The Instrument should transmit and receive all packet data using Consultative Committee
- 1109 for Space Data Systems (CCSDS) primary and secondary headers for packet sequencing
- 1110 and control.
- 1111 Rationale: The use of CCSDS packets for data communication is common practice across
- aerospace flight and ground data systems.
- 1113 9.1.2 Flight Software Update
- 1114 Instrument control flight software should be updatable on orbit through ground command.
- 1115 Rationale: On-orbit flight software updates are a best practice that facilitates improvements
- and/or workarounds deemed necessary through operational experience.
- 1117 9.1.3 Flight Software Update (Partial)
- 1118 Individual memory addresses of instrument control software should be updatable on orbit
- 1119 through ground command.
- 1120 Rationale: On-orbit flight software updates are a best practice that facilitates improvements
- and/or workarounds deemed necessary through operational experience.
- 1122 9.1.4 Use of Preexisting Communication Infrastructure
- 1123 Instrument Developers should consider utilizing the communication infrastructure
- provided by the Host Spacecraft and Satellite Operator for all of the Instrument's space-to-
- 1125 ground communications needs.
- 1126 Rationale: The size, mass, and power made available to the Instrument may not simultaneously
- accommodate a scientific Instrument as well as communications terminals, antennas, and other
- equipment. Additionally, the time required for the Instrument Developer to apply for and secure
- 1129 a National Telecommunications and Information Administration (NTIA) Spectrum Planning
- 1130 Subcommittee (SPS) Stage 4 (operational) Approval to transmit on a particular radio frequency
- band may exceed the schedule available, given the constraints as a hosted payload. A Satellite
- Operator will have already initiated the spectrum approval process that would cover any data the
- 1133 Instrument transmits through the Host Spacecraft. NPR 2570.1B, NASA Radio Frequency (RF)
- 1134 Spectrum Management Manual, details the spectrum approval process for NASA missions.
- 1135 9.2 Electrical Power Interface Reference Material / Best Practices
- **1136** 9.2.1 Discussion
- 1137 The following electrical power guidelines define a common basis for the provision of electrical
- power by spacecraft hosts to potential hosted payload Earth science instruments. This is
- necessary to progress both the design of any instrument prior to the selection of an HPO and
- launch vehicle and to progress the design of the host payload accommodations. The major
- sources from which these best practices were developed are the *General Interface Requirements*
- 1142 Document (GIRD) for EOS Common Spacecraft/Instruments, Electrical Grounding Architecture

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- 1143 for Unmanned Spacecraft, (NASA-HDBK-4001), Mitigating In-Space Charging Effects A
- 1144 Guideline, (NASA-HDBK-4002) and Electrical Bonding for Launch Vehicles, Spacecraft,
- 1145 Payloads and Flight Equipment (NASA-STD-4003).
- Note: This section assumes that the Host Spacecraft will provide access to its Electrical Power
- 1147 System using the interface defined in Section 5.1.
- 1148 9.2.2 Electrical Interface Definitions
- 1149 9.2.2.1 Power Bus Current Rate of Change
- 1150 For power bus loads with current change greater than 2 A, the rate of change of current
- 1151 should not exceed 500 mA/µs.
- 1152 Rationale: This describes the maximum nominal rate of change for instrument electrical current
- to bound nominal and anomalous behavior.
- 1154 9.2.2.2 *Power Bus Isolation*
- 1155 All Instrument power buses (both operational and survival) should be electrically isolated
- 1156 from each other and from the chassis.
- 1157 Rationale: Circuit protection and independence.
- 1158 9.2.2.3 *Power Bus Returns*
- 1159 All Instrument power buses (both operational and survival heater) should have
- 1160 independent power returns.
- 1161 Rationale: Circuit protection and independence.
- 1162 9.2.3 Survival Heaters.
- 1163 9.2.3.1 Survival Heater Power Bus Circuit Failure
- 1164 The Instrument survival heater circuit should prevent a stuck on condition of the survival
- 1165 heaters due to internal failures.
- 1166 Rationale: A stuck-on survival heater could lead to excessive power draw and/or over-
- temperature events in the Instrument or Host Spacecraft. This is normally accomplished by
- using series-redundant thermostats in each survival heater circuit.
- 1169 9.2.3.2 *Survival Heater Power Bus Heater Type*
- 1170 The Instrument should use only resistive heaters (and associated thermal control devices)
- to maintain the Instrument at survival temperature when the main power bus is
- 1172 disconnected from the Instrument.
- 1173 Rationale: This preserves the survival heater power bus for exclusive use of resistive survival
- heaters, whose function is to maintain the Instrument at a minimum turn-on temperature when
- the Instrument Power Buses are not energized.

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- 1176 9.2.3.3 Survival Heater Power Bus Design
- 1177 The system design should be such that having both primary and redundant survival heater
- circuits enabled does not violate any thermal or power requirement.
- 1179 Rationale: This precludes excessive power draw and/or over-temperature events in the
- 1180 Instrument or Host Spacecraft. This is normally accomplished via the application of thermostats
- with different set points in each redundant survival heater circuit.
- 1182 9.2.4 Voltage and Current Transients
- 1183 9.2.4.1 Low Voltage Detection
- 1184 A voltage excursion that causes the spacecraft Primary Power Bus to drop below 22 VDC
- in excess of four seconds constitutes an under-voltage condition. In the event of an under-
- voltage condition, the spacecraft will shed various loads without delay, including the
- 1187 Instrument. A ground command should be required to re-power the load.
- 1188 Rationale: Bounds nominal and anomalous design conditions. Describes "typical" spacecraft
- 1189 CONOPS to the noted anomaly for application to design practice.
- 1190 9.2.4.2 Bus Undervoltage and Overvoltage Transients
- Derating factors should take into account the stresses that components are subjected to
- during periods of undervoltage or overvoltage, including conditions which arise during
- 1193 ground testing, while the bus voltage is slowly brought up to its nominal value.
- 1194 Rationale: Describes a "standard" design practice.
- 1195 9.2.4.3 Bus Undervoltage and Overvoltage Transients
- 1196 The Instrument should not generate a spurious response that can cause equipment damage
- or otherwise be detrimental to the spacecraft operation during bus voltage variation, either
- 1198 up or down, at ramp rates below the limits specified in the sections below, and over the full
- 1199 range from zero to maximum bus voltage.
- 1200 Rationale: the Instrument needs to be able to tolerate appropriate electrical transients without
- 1201 affecting the Host Spacecraft.
- 1202 9.2.4.4 Abnormal Transients Undervoltage
- 1203 An abnormal undervoltage transient event is defined as a transient decrease in voltage on
- 1204 the Power Bus to no less than +10 VDC, maintaining the decreased voltage for no more
- than 10 ms, and returning to its previous voltage in less than 200 ms.
- 1206 9.2.4.5 Abnormal Transients Tolerance
- 1207 The Instrument should ensure that overstress does not occur to the unit during an
- 1208 undervoltage event.
- 1209 Rationale: The Instrument needs to tolerate the abnormal voltage transients, which can be
- expected to occur throughout its mission lifetime.

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- 1211 9.2.4.6 *Abnormal Transients Recovery*
- 1212 Units which shut-off during an undervoltage should return to a nominal power-up state at
- 1213 the end of the transient.
- 1214 Rationale: The Instrument needs to tolerate the abnormal voltage transients, which can be
- expected to occur throughout its mission lifetime.
- 1216 9.2.4.7 Abnormal Transients Overvoltage
- 1217 An overvoltage transient event is defined as an increase in voltage on the Power Bus to no
- 1218 greater than +40 VDC, maintaining the increased voltage for no more than 10 ms, and
- 1219 returning to its previous voltage in less than 200 ms.
- 1220 Rationale: A necessary definition of an Abnormal Transient Overvoltage
- 1221 9.2.4.8 *Instrument Initial In-rush Current*
- 1222 After application of +28 VDC power at t_0 , the initial inrush (charging) current due to
- 1223 distributed capacitance, EMI filters, etc., should be completed in 10 μs with its peak no
- 1224 greater than 10 A.
- 1225 Rationale: Bounds nominal and anomalous behavior.
- 1226 9.2.4.9 Instrument Initial In-rush Current Rate of Change
- 1227 The rate of change of inrush current after the initial application of +28V power should not
- 1228 exceed 20 mA/μs.
- 1229 Rationale: Bounds nominal and anomalous behavior.
- 1230 9.2.4.10 Instrument In-rush Current after 10 μs
- 1231 After 10 μs, the transient current peak should not exceed three times the maximum steady
- 1232 state current.
- 1233 Rationale: Bounds nominal and anomalous behavior.
- 1234 9.2.4.11 *Instrument Steady State Operation*
- 1235 Steady state operation should be attained within 50 ms from turn-on or transition to
- 1236 OPERATION mode, except for motors.
- 1237 Rationale: Bounds nominal and anomalous behavior with a maximum transient duration of 50
- 1238 ms.
- 1239 9.2.4.12 Instrument Turn-off Peak Voltage Transients
- 1240 The peak voltage of transients generated on the Instrument side of the power relay caused
- by inductive effects of the load should fall within the -2 VDC to +40 VDC range.
- 1242 Rationale: Bounds nominal behavior

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- 1243 9.2.4.13 Instrument Turn-off Transient Suppression
- 1244 The Instruments should use suppression devices, such as diodes, across all filter inductors,
- relay coils, or other energy sources that could induce transients on the power lines during
- 1246 turn-off.
- 1247 Rationale: Describes design "standard practice."
- 1248 9.2.4.14 Reflected Ripple Current Mode Changes
- 1249 The load current ripple due to motor rotation speed mode changes should not exceed 2
- 1250 times the steady state current during the period of the motor spin-up or spin-down.
- 1251 Rationale: Bounds nominal behavior.
- 1252 9.2.4.15 Instrument Operational Transients Current Limit
- 1253 Operational transients that occur after initial turn-on should not exceed 125% of the peak
- 1254 operational current drawn during normal operation.
- 1255 Rationale: Bounds nominal behavior.
- 1256 9.2.4.16 Instrument Reflected Ripple Current
- 1257 The peak-to-peak load current ripple generated by the Instrument should not exceed 25%
- of the average current on any Power Feed bus.
- 1259 Rationale: Bounds nominal behavior.
- 1260 9.2.5 Overcurrent Protection
- 1261 9.2.5.1 Overcurrent Protection Definition
- 1262 The analysis defining the overcurrent protection device specification(s) should consider
- 1263 turn-on, operational, and turn-off transients.
- 1264 Rationale: Describes conditions necessary for inclusion in the "standard" design practice.
- 1265 9.2.5.2 *Overcurrent Protection Harness Compatibility*
- Harness wire sizes should be consistent with overcurrent protection device sizes and de-
- 1267 rating factors.
- 1268 Rationale: Describes a "standard" design practice.
- 1269 9.2.5.3 Overcurrent Protection Device Size Documentation
- 1270 The agreed-upon type, size, and characteristics of the overcurrent protection device(s) should be
- documented in the Spacecraft to Instrument ICD.
- 1272 The EICD will document the type, size, and characteristics of the overcurrent protection
- 1273 devices.
- 1274 Rationale: Describes "standard practice" EICD elements.

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- 1275 9.2.5.4 Instrument Overcurrent Protection
- 1276 All Instrument overcurrent protection devices should be accessible at the Spacecraft
- 1277 integration level without any disassembly of the Instrument.
- 1278 Rationale: Accessible overcurrent protection devices allow Systems Integrator technicians to
- more easily restore power to the Instrument in the event of an externally-induced overcurrent.
- 1280 9.2.5.5 Instrument Fault Propagation Protection
- 1281 The Instrument and spacecraft should not propagate a single fault occurring on either the
- 1282 "A" or "B" power interface circuit, on either side of the interface, to the redundant
- 1283 interface or Instrument.
- Rationale: This preserves redundancy by keeping faulty power circuits from impacting alternate
- 1285 power sources.
- 1286 9.2.5.6 Testing of Instrument High-Voltage Power Supplies in Ambient Conditions
- 1287 Instrument high-voltage power supplies should operate nominally in ambient atmospheric
- 1288 conditions.
- 1289 Rationale: This allows simplified verification of the high-voltage power supplies.
- 1290 If the high-voltage power supplies cannot operate nominally in ambient conditions, then
- the Instrument should enable a technician to manually disable the high-voltage power
- 1292 supplies.
- Rationale: This allows verification of the Instrument by bypassing the HV power supplies that do
- 1294 not function in ambient conditions.
- 1295 9.2.5.7 *Instrument High-Voltage Current Limiting*
- 1296 The output of each Instrument's high-voltage supply should be current limited to prevent
- the supply's discharge from damaging the Spacecraft and other Instruments.
- 1298 Rationale: This prevents the power supply's discharge from damaging the Host Spacecraft or
- 1299 other payloads.
- 1300 9.2.6 Connectors
- 1301 The following best practices apply to the selection and use of all interface connectors.
- 1302 9.2.6.1 Instrument Electrical Power System Connector and Harnessing
- 1303 The Instrument electrical power system harnessing and connectors should conform to
- 1304 GSFC-733-HARN, IPC J-STD-001ES and NASA-STD-8739.4.
- 1305 Rationale: Describes the appropriate design practices for all Instrument electrical power
- 1306 connections and harnessing.

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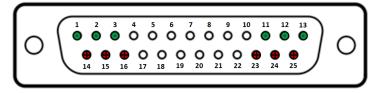
- **1307** 9.2.6.2 *Connector Savers*
- 1308 Throughout all development, integration, and test phases, connector savers should be used
- 1309 to preserve the mating life of component flight connectors.
- 1310 Rationale: This practice serves to preserve the number of mate/de-mate cycles any particular
- 1311 flight connector experiences. Mate/de-mate cycles are a connector life-limiting operation. This
- practice also protects flight connects form damage during required connector mate/de-mate
- 1313 operations.
- 1314 9.2.6.3 Connector Separation
- 1315 Separate harness interface connectors should be provided on all components for each of the
- 1316 following functions:
- 1317 The Instrument should physically separate the electric interfaces for each of the following
- 1318 functions using distinct connectors:
- 1319 1) +28 VDC bus power and return
- 1320 2) Telemetry and command signals with returns
- 1321 3) Deployment actuation power and return (where applicable)
- 1322 Rationale: A "standard" design practice to preclude mismating and to simplify test and anomaly
- 1323 resolution.
- 1324 9.2.6.4 *Command and Telemetry Returns*
- 1325 Telemetry return and relay driver return pins should reside on the same connector(s) as
- 1326 the command and telemetry signals.
- 1327 Rationale: A "standard" design practice to simplify testing and anomaly resolution.
- 1328 9.2.6.5 Connector Usage and Pin Assignments
- 1329 Harness side power connectors and all box/bracket-mounted connectors supplying power
- 1330 to other components should have female contacts.
- 1331 Rationale: Unexposed power supply connector contacts preclude arcing, mismating, and contact
- 1332 shorting.
- 1333 9.2.6.6 Connector Function Separation
- 1334 Incompatible functions should be physically separated.
- Rationale: A "standard" design practice to ensure connector conductor self-compatibility that
- precludes arcing and inductive current generation.
- 1337 9.2.6.7 *Connector Derating*
- 1338 Instrument and Spacecraft should derate electrical connectors using *Electronic Parts*,
- 1339 Materials, and Processes for Space and Launch Vehicles (MIL-HDBK-1547A) as a guide.
- 1340 Rationale: A "standard" design practice.

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- **1341** 9.2.6.8 *Connector Access*
- 1342 At least 50 mm of clearance should exist around the outside of mated connectors.
- Rationale: Ensures the ability to perform proper connector mate/de-mate operations.
- 1344 9.2.6.9 *Connector Engagement*
- 1345 Connectors should be mounted to ensure straight and free engagement of the contacts.
- 1346 Rationale: This precludes mismating connectors.
- 1347 9.2.6.10 Power Connector Type
- 1348 The Instrument power connectors should be space-flight qualified MIL-DTL-24308, Class
- 1349 M, Subminiature Rectangular connectors with standard density size 20 crimp contacts and
- 1350 conform to GSFC S-311-P-4/09.
- Rationale: Connector sizes and types selected based upon familiarity, availability, and space
- 1352 flight qualification.
- 1353 9.2.6.11 Power Connector Size and Conductor Gauge
- 1354 The Instrument power connectors should be 20 AWG, 9 conductor (shell size 1) or 15
- 1355 conductor (shell size 2) connectors.
- 1356 Rationale: Application of stated design practices to the CII instrument power bus connectors.
- 1357 9.2.6.12 Power Connector Pin Out
- The Instrument power connectors should utilize the supply and return pin outs defined in Table
- 9-1 and identified in Figure 9-1 thru Figure 9-3. *Note that the connectors are depicted with the*
- instrument side of the connector (pins) shown while the spacecraft side of the connector (sockets)
- is the mirror image.

Table 9-1: Instrument Power Connector Pin Out Definition

Power Bus	Circuit	Supply Conductor	Return Conductor
		Position	Position
#1	A & B	14,15,16,23,24,25	1,2,3,11,12,13
#2	A & B	9,10,11,13,14,15	1,2,3,6,7,8
Survival Heater	A & B	6,7,8,9	1,2,4,5



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Figure 9-1: Instrument Side Power Bus #1 Circuit A & Circuit B

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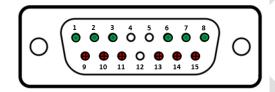


Figure 9-2: Instrument Side Power Bus #2 Circuit A & Circuit B

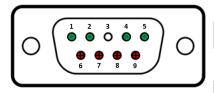
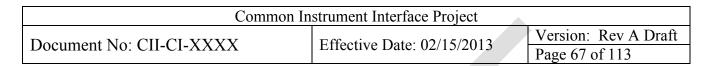
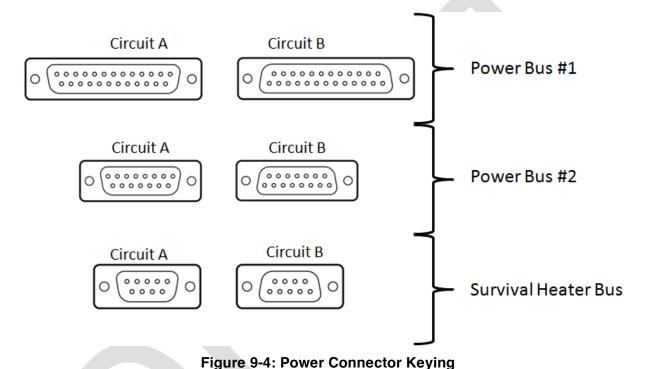


Figure 9-3: Instrument Side Survival Heater Power Bus Circuit A & Circuit B

- 1369 9.2.6.13 SpaceWire Connectors and Harnessing
- 1370 The Instrument SpaceWire harnessing and connectors should conform to ECSS-E-ST-50-
- 1371 12C.
- 1372 Rationale: Describes the appropriate design practice for all SpaceWire connections and
- harnessing.
- 1374 9.2.6.14 Power Connector Provision
- 1375 The Instrument Provider should furnish all instrument power mating connectors (Socket
- 1376 Side) to the Spacecraft Manufacturer for interface harness fabrication.
- 1377 Rationale: Describes the appropriate design practice for all SpaceWire connectors.
- 1378 9.2.6.15 *Power Connector Conductor Size and Type*
- 1379 The Instrument should have size 20 socket crimp contacts on the Instrument side power
- 1380 connectors and size 20 pin crimp contacts on the Spacecraft side power connectors.
- Rationale: Application of the conductor size and type selected for the CII instrument power bus
- 1382 connectors to the corresponding instrument power connectors.
- 1383 9.2.6.16 *Power Connector Keying*
- 1384 The instrument power connectors should be keyed as defined in Figure 9-4.





1387 9.2.6.17 Connector Type Selection

1388 All connectors to be used by the Instrument should be selected from the Goddard

1389 Spaceflight Center (GSFC) Preferred Parts List (PPL).

1390 Rationale: Utilizing the GSPC PPL simplifies connector selection, since all of its hardware is

1391 spaceflight qualified.

1392 9.2.6.18 Flight Plug Installation

1393 Flight plugs requiring installation prior to launch should be capable of being installed at

1394 the Spacecraft level.

1395 Rationale: Ensures necessary access.

1396 9.2.6.19 *Test Connector Location and Types*

1397 Test connector and coupler ports should be accessible without disassembly throughout

1398 integration of the Instrument and Host Spacecraft.

1399 Rationale: This reduces the complexity and duration of integrated testing and simplifies preflight

anomaly resolution.

1401 9.3 Mechanical Interface Reference Material / Best Practices

1402 9.3.1 Minimum Fixed-Base Frequency

1403 The Instrument should have a fixed based frequency greater than 50 Hz.

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- 1404 Rationale: This minimum fixed-based frequency exceeds the composite guidance of publically
- available Launch Vehicle Payload Planner's Guidebooks as applicable to primary spacecraft
- 1406 structures operating in both LEO and GEO regimes. To some extent, the Instrument will affect
- the spacecraft frequency depending on the payload's mass and mounting location. Spacecraft
- 1408 Manufacturers may negotiate for a greater fixed-based frequency for hosted payloads until the
- maturity of the instrument can support Coupled Loads Analysis.
- 1410 9.3.2 Mass Centering
- 1411 The Instrument center of mass should be less than 5 cm radial distance from the $Z_{instrument}$
- 1412 axis, defined as the center of the Instrument mounting bolt pattern.
- 1413 Rationale: Engineering analysis determined guideline Instrument mass centering parameters
- based on comparisons to spacecraft envelope in the STP-SIV Payload User's Guide.
- 1415 The Instrument center of mass should be located less than half of the Instrument height
- 1416 above the Instrument mounting plane.
- 1417 Rationale: Engineering analysis determined guideline Instrument mass centering parameters
- based on comparisons to spacecraft envelope in the STP-SIV Payload User's Guide.
- 1419 9.3.3 <u>Documentation of Mechanical Properties</u>
- **1420** 9.3.3.1 *Envelope*
- 1421 The MICD will document the Instrument component envelope (including kinematic
- 1422 mounts and MLI) as "not to exceed" dimensions.
- 1423 Rationale: Defines the actual maximum envelope within which the instrument resides.
- **1424** 9.3.3.2 *Mass*
- 1425 [LEO] The MICD will document the mass of the Instrument, measured to $\pm 1\%$.
- 1426 [GEO] The MICD will document the mass of the Instrument, measured to less than 0.2%.
- 1427 Rationale: To ensure that accurate mass data is provided for analytic purposes.
- **1428** 9.3.3.3 *Center of Mass*
- 1429 [LEO] The MICD will document the launch and or-orbit centers of mass of each
- 1430 Instrument, references to the Instrument coordinate axes and measured to \pm 5 mm.
- 1431 [GEO] The MICD will document the launch and on-orbit centers of mass of each
- 1432 Instrument, referenced to the Instrument coordinate axes and measured to ± 1 mm.
- 1433 Rationale: To ensure that accurate CG data is provided for analytic purposes.
- **1434** 9.3.3.4 *Moment of Inertia*
- 1435 [LEO] The MICD will document the moments of inertia, measured to less than 10%
- 1436 [GEO] The MICD will document the moments of inertia, measured to less than 1.5%.

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- 1437 Rationale: To ensure that accurate moments of inertia data is provided for analytic purposes.
- 1438 9.3.3.5 Constraints on Moments of Inertia
- 1439 The MICD will document the constraints to the moments and products of inertia available
- 1440 to the Instrument.
- 1441 Rationale: To define the inertial properties envelope within which the Instrument may operate
- and not adversely affect spacecraft and primary instrument operations.
- 1443 9.3.4 Dynamic Properties
- 1444 9.3.4.1 Documentation of Dynamic Envelope or Surfaces
- 1445 The MICD will document the initial and final configurations, as well as the swept volumes
- of any mechanisms that cause a change in the external envelope or external surfaces of the
- 1447 Instrument.
- 1448 Rationale: To define variations in envelope caused by deployables.
- 1449 9.3.4.2 Documentation of Dynamic Mechanical Elements
- 1450 The MICD will document the inertia variation of the Instrument due to movable masses,
- 1451 expendable masses, or deployables.
- 1452 Rationale: Allows spacecraft manufacturer to determine the impact of such variations on
- spacecraft and primary payload.
- 1454 9.3.4.3 *Caging During Test and Launch Site Operations*
- 1455 Instrument mechanisms that require caging during test and launch site operations should
- 1456 cage when remotely commanded.
- 1457 Rationale: To allow proper instrument operation during integration and test.
- 1458 Instrument mechanisms that require uncaging during test and launch site operations
- should uncage when remotely commanded.
- 1460 Rationale: To allow proper instrument operation during integration and test.
- 1461 Instrument mechanisms that require caging during test and launch site operations should
- cage when accessible locking devices are manually activated.
- 1463 Rationale: To allow proper instrument operation during integration and test.
- 1464 Instrument mechanisms that require uncaging during test and launch site operations
- should uncage when accessible unlocking devices are manually activated.
- 1466 Rationale: To allow proper instrument operation during integration and test.

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- 1467 9.3.5 Instrument Mounting
- 1468 9.3.5.1 *Documentation of Mounting*
- 1469 The MICD will document the mounting interface, method, and geometry, including ground
- strap provisions and dimensions of the holes for mounting hardware.
- 1471 Rationale: To ensure no ambiguity of mounting interface between instrument and spacecraft.
- 1472 9.3.5.2 Documentation of Instrument Mounting Location
- 1473 The MICD will document the mounting location of the Instrument on the Host Spacecraft.
- 1474 Rationale: To ensure no ambiguity of mounting location on spacecraft.
- **1475** 9.3.5.3 *Metric Units*
- 1476 The MICD will specify whether mounting fasteners will conform to SI or English unit
- 1477 standards.
- 1478 Rationale: Metric hardware are not exclusively used industry wide. Choice of unit system likely
- will be set by spacecraft manufacturer.
- 1480 9.3.5.4 Documentation of Finish and Flatness Guidelines
- 1481 The MICD will document finish and flatness guidelines for the mounting surfaces.
- Rationale: To ensure no ambiguity of finish and flatness requirements at instrument interface.
- 1483 9.3.5.5 Drill Template Usage
- 1484 The MICD will document the drill template details and serialization.
- 1485 Rationale: Drill template details will be on record.
- 1486 The Instrument Developer should drill spacecraft and test fixture interfaces using the
- 1487 MICD defined template.
- 1488 Rationale: A common drill template will ensure proper alignment and repeatability of mounting
- 1489 holes.
- 1490 9.3.5.6 *Kinematic Mounts*
- 1491 The Instrument Provider should provide all kinematic mounts.
- Rationale: If the instrument requires kinematic mounts, they should be the responsibility of the
- instrument provider due to their knowledge of the instrument performance requirements.
- 1494 9.3.5.7 Fracture Critical Components of Kinematic Mounts
- 1495 Kinematic mounts should comply with all analysis, design, fabrication, and inspection
- requirements associated with fracture critical components as defined by NASA-STD-5019.
- 1497 Rationale: Kinematic mount failure is a potential catastrophic hazard to the Instrument and the
- 1498 Host Spacecraft.

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9.3.6 <u>Instrument Alignment</u> 9.3.6.1 <i>Documentation of Coordina</i> The MICD will document the Instrum		e.
Rationale: To ensure there is no ambiguregarding the Instrument Reference Coo	•	raft manufacturers
9.3.6.2 Instrument Interface Alignment Interface Alignment Interface Alignment Cube (IAC), and Coordinate Frame.	ent requirements, the Instrument	
The Spacecraft should contain an IAC Coordinate Frame.	C that aligns with the Instrument	Reference
Rationale: To aid in proper alignment o Test.	f the instrument to the spacecraft de	uring Integration and
9.3.6.3 Interface Alignment Cube L The Instrument Developer should mointegration with the Spacecraft from	ount the IAC such that it is visible	<u>e</u>
Rationale: Observation of IAC from at	least two directions is required for a	alignment.
9.3.6.4 Interface Alignment Cube L The MICD will document the location		n the Instrument.
Rationale: To have a record of the IAC	locations.	
9.3.6.5 Instrument Boresight The Instrument Developer should me Instrument boresight.	easure the alignment angles betwe	een the IAC and the
Rationale: Since this knowledge is critic for taking the measurement.	cal to the instrument provider they	should be responsible
The MICD will document the alignment boresight.	ent angles between the IAC and t	he Instrument
Pationala: To record the actual alignma	ent analy in aggs it is needed for late	or analyzaia

- 1526 Rationale: To record the actual alignment angle in case it is needed for later analysis.
- 1527 9.3.6.6 *Pointing Accuracy, Knowledge, and Stability*

- 1528 The MICD will document the Host Spacecraft's required pointing accuracy, knowledge,
- and stability capabilities in order for the Instrument to meet its operational requirements.
- 1530 Rationale: To establish that spacecraft's pointing accuracy, knowledge and stability
- specifications meet requirements of instrument operation.

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- 1532 9.3.7 <u>Integration and Test</u>
 1533 9.3.7.1 *Installation/Removal*
- 1534 The Instrument should be capable of being installed in its launch configuration without
- 1535 disturbing the primary payload.
- 1536 The Instrument should be capable of being removed in its launch configuration without
- 1537 disturbing the primary payload.
- 1538 Rationale: Primary payload safety.
- 1539 9.3.7.2 *Mechanical Attachment Points*
- 1540 The Instrument should provide mechanical attachment points that will be used by a
- 1541 handling fixture during integration of the instrument.
- Rationale: The handling fixtures will be attached to the Instrument while in the Integration and
- 1543 Test environment.
- 1544 The MICD will document details of the mechanical attachment points used by the handling
- 1545 fixture.
- 1546 Rationale: To ensure handling fixture attachment points are properly recorded.
- **1547** 9.3.7.3 *Load Margins*
- 1548 Handling and lifting fixtures should function according to their operational specifications
- 1549 at five (5) times limit load for ultimate.
- 1550 Handling and lifting fixtures should function according to their operational specifications
- at three (3) times limit load for yield.
- 1552 Handling fixtures should be tested to two (2) times working load.
- 1553 Rationale: All three load margins maintain personnel and instrument safety.
- 1554 9.3.7.4 Responsibility for Providing Handling Fixtures
- 1555 The Instrument Provider should provide proof-tested handling fixtures for each
- 1556 component with mass in excess of 16 kg.
- 1557 Rationale: This guideline protects personnel safety.
- 1558 9.3.7.5 Accessibility of Red Tag Items
- 1559 All items intended for pre-flight removal from the Instrument should be accessible without
- 1560 disassembly of another Instrument component.
- 1561 Rationale: Instrument safety.

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- 1562 9.3.7.6 Marking and Documentation of Test Points and Test Guidelines
- 1563 All test points and I&T interfaces on the Instrument should be visually distinguishable
- 1564 from other hardware components to an observer standing 4 feet away.
- 1565 Rationale: Clear visual markings mitigate the risk that Integration and test personnel will attempt
- to connect test equipment improperly, leading to Instrument damage. Four feet exceeds the
- length of most human arms and ensures that the technician would see any markings on hardware
- he intends to connect test equipment to.
- 1569 The MICD will document all test points and test guidelines.
- 1570 Rationale: To ensure no ambiguity of Integration and Test interfaces and test points and to aide
- in developing I&T procedures.
- 1572 9.3.7.7 *Orientation Constraints During Test*
- 1573 The MICD will document instrument mechanisms, thermal control, or any exclusions to
- 1574 testing and operations related to orientations.
- 1575 Rationale: This documents any exceptions to the 1g functionality described in section 6.2.1
- **1576** 9.3.7.8 *Temporary Items*
- 1577 All temporary items to be removed following test should be visually distinguishable from
- other hardware components to an observer standing 4 feet away.
- 1579 Rationale: Any preflight removable items need to be obvious to casual inspection to mitigate the
- risk of them causing damage or impairing spacecraft functionality during launch/operations.
- 1581 The MICD will document all items to be installed prior to or removed following test and all
- items to be installed or removed prior to flight.
- 1583 Rationale: To ensure no ambiguity of installed and/or removed items during Integration and Test
- through documentation.
- **1585** 9.3.7.9 *Temporary Sensors*
- 1586 The Instrument should accommodate temporarily installed sensors and supporting
- 1587 hardware to support environmental testing.
- 1588 Rationale: To facilitate environmental testing.
- 1589 Example sensors include acceleration sensors and thermal monitors.
- **1590** 9.3.7.10 *Captive Hardware*
- 1591 The Instrument Developer should utilize captive hardware for all items planned to be
- installed, removed, or replaced during integration, except for Instrument mounting
- 1593 hardware and MLL.

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- 1594 Rationale: Captive hardware reduces the danger to the Host Spacecraft, Instrument, and
- personnel from fasteners dropped during integration.
- 1596 9.3.7.11 *Venting Documentation*
- 1597 The MICD will document the number, location, size, vent path, and operation time of
- 1598 Instrument vents.
- 1599 Rationale: This eliminates ambiguity regarding venting the Instrument and how it may pertain to
- the Host Spacecraft and primary instrument operations.
- 1601 9.3.7.12 Purge Documentation
- 1602 The MICD will document Instrument purge guidelines, including type of purge gas, flow
- rate, gas purity specifications, filter pore size, type of desiccant (if any), and tolerable
- interruptions in the purge (and their duration).
- Rationale: This ensures compatibility of instrument purging procedures with respect to the Host
- 1606 Spacecraft and primary instrument.
- 1607 9.3.7.13 Combined Structural Dynamics Analysis Results
- 1608 The Spacecraft Manufacturer should furnish the combined structural dynamics analysis
- 1609 results to the respective Instrument Provider.
- 1610 Rationale: To ensure the combined structural dynamics does not impede instrument operations.
- 1611 9.3.7.14 *Non-Destructive Evaluation*
- 1612 Kinematic mount flight hardware should show no evidence of micro cracks when inspected
- 1613 using Non-Destructive Evaluation (NDE) techniques following proof loading.
- 1614 Rationale: To ensure kinematic mounts meet load requirements without damage.
- 1615 The MICD will document the combined structural dynamics analysis.
- 1616 Rationale: Record maintenance.
- 1617 9.4 Thermal Interface Reference Material / Best Practices
- 1618 9.4.1 Heat Management Techniques
- 1619 9.4.1.1 *Heat Transfer Hardware*
- 1620 The Instrument Developer should consider implementing heat pipes and high thermal
- 1621 conductivity straps to transfer heat within the Instrument.
- Rationale: A spacecraft would likely more easily accommodate an instrument whose thermal
- design is made more flexible by the inclusion of heat transfer hardware.
- 1624 9.4.1.2 *Survivability at Very Low Temperature*
- 1625 The Instrument Developer should consider using components that can survive at -55° C to
- minimize the survival power demands on the Spacecraft.

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- 1627 Rationale: -55° C is a common temperature to which space components are certified. Using
- 1628 components certified to this temperature decreases the survival heater power demands placed
- 1629 upon the Host Spacecraft.
- 1630 9.4.1.3 *Implementation of Cooling Function*
- 1631 The Instrument Developer should consider implementing thermoelectric coolers or
- mechanical coolers if cryogenic temperatures are required for the instrument to ease the
- 1633 restrictions on Instrument radiator orientations.
- Rationale: Thermoelectric or mechanical coolers provide an alternative technique to achieve very
- low temperatures that do not impose severe constraints on the placement of the radiator.
- 1636 9.4.1.4 *Implementation of High Thermal Stability*
- 1637 The Instrument Developer should consider implementing high thermal capacity hardware,
- such as phase change material, in order to increase the Instrument's thermal stability.
- 1639 Rationale: Some optical instruments require very high thermal stability and given the relatively
- low masses expected in CII Instruments, incorporating phase change material for thermal storage
- is a useful technique.
- 1642 9.4.2 Survival Heaters
- 1643 The use of survival heaters is a technique to autonomously apply heat to an Instrument in the
- event that the thermal subsystem does not perform nominally, either due to insufficient power
- 1645 from the Host Spacecraft or an inflight anomaly.
- 1646 9.4.2.1 *Survival Heater Responsibility*
- 1647 The Instrument Provider should provide and install all Instrument survival heaters.
- 1648 Rationale: Survival heaters are a component of the Instrument.
- 1649 9.4.2.2 *Mechanical Thermostats*
- 1650 The Instrument should control Instrument survival heaters via mechanical thermostats.
- 1651 Rationale: Mechanical thermostat allows control of the survival heaters while the instrument
- avionics are not operating.
- 1653 9.4.2.3 Survival Heater Documentation
- 1654 The TICD will document survival heater characteristics and mounting details.
- Rationale: This will capture the agreements negotiated by the Spacecraft Manufacturer and
- 1656 Instrument Developer.
- 1657 9.4.2.4 *Minimum Turn-On Temperatures*
- 1658 The Instrument should maintain the temperature of its components at a temperature no
- lower than that required to safely energize and operate the components.
- 1660 Rationale: Some electronics require a minimum temperature in order to safely operate.

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- 1661 9.4.3 Thermal Performance and Monitoring
- 1662 9.4.3.1 *Surviving Arbitrary Pointing Orientations*
- 1663 The Instrument should be capable of surviving arbitrary pointing orientations without
- permanent degradation of performance for a minimum of four (4) orbits with survival
- 1665 power only.
- Rationale: This is a typical NASA earth orbiting science instrument survival requirement.
- 1667 9.4.3.2 *Documentation of Temperature Limits*
- 1668 The TICD will document temperature limits for Instrument components during ground
- 1669 test and on-orbit scenarios.
- 1670 Rationale: This will provide values for the Integration and Test technicians to monitor and
- manage.
- 1672 9.4.3.3 Documentation of Monitoring Location
- 1673 The TICD will document the location of all Instrument temperature sensors.
- 1674 Rationale: This is the standard means to documents the agreement between the spacecraft and
- 1675 instrument
- 1676 9.4.3.4 *Temperature Monitoring During OFF Mode*
- 1677 The Instrument Designer should assume that the Host Spacecraft will monitor only one
- temperature on the spacecraft side of the payload interface when the payload is off. During
- extreme cases such as host anomalies, however, even this temperature might not be
- 1680 available.
- Rationale: This limits the demands that the Instrument may place on the Host Spacecraft.
- 1682 9.4.3.5 Thermal Control Hardware Documentation
- 1683 The TICD will document Instrument thermal control hardware.
- Rationale: This is the standard means to documents the agreement between the spacecraft and
- 1685 instrument
- 1686 9.4.3.6 Thermal Performance Verification
- 1687 The Instrument Developer should verify the Instrument thermal control system's ability to
- 1688 maintain hardware within allowable temperature limits either empirically by thermal
- balance testing or by analysis for conditions that cannot be ground tested.
- Rationale: These verification methods ensure that the Instrument's thermal performance meets
- the guidelines and agreements documented in the TICD.

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- 1692 9.5 Environmental Reference Material / Best Practices
- **1693** 9.5.1 Introduction
- 1694 The following environmental best practices provide potential Earth Science instrument and HPO
- spacecraft manufacturers a common design and analysis basis in order to progress the design of
- instrument prior to selection of a Host Spacecraft and launch vehicle.
- 1697 9.5.2 Radiation-Induced SEE
- 1698 The following best practices describe how the Instrument should behave in the event that a
- 1699 radiation-induced SEE does occur.
- 1700 9.5.2.1 Temporary Loss of Function or Loss of Data
- 1701 Temporary loss of function or loss of data is permitted, provided that the loss does not
- 1702 compromise instrument health and full performance can be recovered rapidly.
- 1703 Rationale: Identifies that a temporary loss of function and/or data is permissible in support of
- 1704 correcting anomalous operations. This includes autonomous detection and correction of
- anomalous operations as well as power cycling.
- 1706 9.5.2.2 Restoration of Normal Operation and Function
- 1707 To minimize loss of data, normal operation and function should be restored via internal
- 1708 correction methods without external intervention.
- 1709 Rationale: Identifies that autonomous fault detection and correction should be implemented.
- 1710 9.5.2.3 *Irreversible Actions*
- 1711 Irreversible actions should not be permitted. The hardware design should have no parts
- 1712 which experience radiation induced latch-up to an effective LET of 75 MeV/mg/cm² and a
- 1713 fluence of 10^7 ions/cm².
- 1714 Rationale: Identifies limitations for radiation induced latch-up and prescribes both a LET and an
- ion fluence immunity level
- 1716 9.6 Software Engineering Reference Material / Best Practices
- 1717 The Instrument System's software should comply with Class C software development
- 1718 requirements and guidelines, in accordance with NPR 7150.2A
- 1719 Rationale: NPR 7150.2A Appendix E assigns Class C to "flight or ground software that is
- 1720 necessary for the science return from a single (non-primary) instrument." NASA Class C
- 1721 software is any flight or ground software that contributes to mission objectives, but whose
- 1722 correct functioning is not essential to the accomplishment of primary mission objectives. In this
- 1723 context, primary mission objectives are exclusively those of the Host Spacecraft.

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1724 9.7 Contamination Reference Material / Best Practices

1725 9.7.1 Assumptions

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- 1) During the matching process, The Host Spacecraft Owner/Integrator and the Instrument Developer will negotiate detailed parameters regarding contamination control. The Contamination Interface Control Document (CICD) will record those parameters and decisions.
- 2) The Instrument Developer will ensure that any GSE accompanying the Instrument is cleanroom compatible in accordance with the CICD.
 - 3) The Instrument Developer will ensure that any GSE accompanying the Instrument into a vacuum chamber during Spacecraft thermal-vacuum testing is vacuum compatible in accordance with the CICD.
 - 4) The Host Spacecraft Manufacturer/Systems Integrator will attach the Instrument to the Host Spacecraft such that the contamination products from the vents of the Instrument do not directly impinge on the contamination-sensitive surfaces nor directly enter the aperture of another component of the Spacecraft system.
 - 5) The Host Spacecraft Manufacturer/Systems Integrator will install protective measures as provided by the Instrument Provider to protect sensitive Instrument surfaces while in the Shipment, Integration and Test, and Launch environments.
 - 6) The Launch Vehicle Provider will define the upper limit for the induced contamination environment. This is typically defined as the total amount of molecular and particulate contamination deposited on exposed spacecraft surfaces from the start of payload fairing encapsulation until the upper stage separation and contamination collision avoidance maneuver (CCAM).
- 1747 9.7.2 Instrument Generated Contamination
- 1748 9.7.2.1 *Verification of Cleanliness*
- 1749 The Instrument Developer should verify by test the cleanliness of the instrument exterior
- 1750 surfaces documented in the CICD, prior to delivery to the Spacecraft
- 1751 Manufacturer/Systems Integrator.
- 1752 Rationale: The Instrument must meet surface cleanliness requirements that are consistent with
- the cleanliness requirements as specified for the Host Spacecraft by the Spacecraft Manufacturer.
- 1754 A record of the cleanliness verification should be provided to the Host Spacecraft Manufacturer
- prior to Instrument integration with the Host Spacecraft.
- 1756 9.7.2.2 *Instrument Sources of Contamination*
- 1757 The CICD will document all sources of contamination that can be emitted from the
- 1758 Instrument.
- 1759 Rationale: This determines the compatibility of the Instrument with the Host Spacecraft and
- 1760 mitigate the risk of Instrument-to-Host-Spacecraft cross contamination.

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- 1761 9.7.2.3 *Instrument Venting Documentation*
- 1762 The CICD will document the number, location, size, vent path, and operation time of all
- 1763 Instrument vents.
- 1764 Rationale: Mitigation of Instrument-to-Host-Spacecraft cross contamination (See 9.7.2.2)
- 1765 9.7.2.4 *Flux of outgassing products*
- 1766 The CICD will document the flux (g/cm²/s) of outgassing products issuing from the
- 1767 primary Instrument vent(s).
- 1768 Rationale: Mitigation of Instrument-to-Host-Spacecraft cross contamination (See 9.7.2.2)
- **1769** 9.7.2.5 *Sealed Hardware*
- 1770 The Instrument should prevent the escape of actuating materials from Electro-explosive
- devices (EEDs), hot-wax switches, and other similar devices.
- 1772 Rationale: Mitigation of Instrument-to-Host-Spacecraft cross contamination (See 9.7.2.2)
- 1773 9.7.2.6 Nonmetallic Materials Selection
- 1774 The Instrument design should incorporate only those non-metallic materials that meet the
- 1775 nominal criteria for thermal-vacuum stability: Total Mass Loss (TML) ≤ 1.0 %, Collected
- 1776 Volatile Condensable Material (CVCM) \leq 0.1 %, per ASTM E595 test method.
- 1777 Rationale: Host Spacecraft Manufacturers generally require that all nonmetallic materials
- 1778 conform to the nominal criteria for thermal-vacuum stability. A publicly accessible database of
- materials tested per ASTM E595 is available at: www.outgassing.nasa.gov Note: Some Host
- 1780 Spacecraft Manufacturers may require lower than the nominal levels of TML and CVMC.
- 1781 9.7.2.7 Wiring and MLI Cleanliness Guidelines
- 1782 The CCID will document thermal vacuum bakeout requirements for Instrument wiring
- 1783 harnesses and MIL.
- 1784 Rationale: Thermal vacuum conditioning of materials and components may be necessary to
- 1785 meet Spacecraft contamination requirements.
- 1786 9.7.2.8 Particulate Debris Generation
- 1787 The Instrument design should avoid the use of materials that are prone to produce
- 1788 particulate debris.
- 1789 Rationale: Host Spacecraft Manufacturers generally prohibit materials that are prone to produce
- particulate debris, either from incidental contact or though friction or wear during operation.
- 1791 Therefore, such materials, either in the construction of the payload or ground support equipment,
- should be avoided. Where no suitable alternative material is available, an agreement with the
- Host Spacecraft will be necessary and a plan to mitigate the risk posed by the particulate matter
- 1794 implemented.

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- 1795 9.7.2.9 Spacecraft Integration Environments
- 1796 The Instrument should be compatible with processing in environments ranging from IEST-
- 1797 STD-1246 ISO-6 to ISO-8.
- 1798 Rationale: Spacecraft integration facilities may vary in cleanliness and environmental control
- 1799 capabilities depending on the Spacecraft Manufacturer and integration/test venue. Instruments
- and associated ground support equipment should be compatible with protocols contamination
- 1801 control of ISO-6 cleanroom environments. Instruments should be compatible with operations in
- up to ISO-8 environments, employing localized controls such as bags, covers, and purges to
- preserve cleanliness; such controls must be integrated into the spacecraft integrations process.
- 1804 9.7.3 Accommodation of Externally Generated Contamination
- 1805 9.7.3.1 *Protective Covers: Responsibility*
- 1806 The Instrument Developer should provide protective covers for any contamination-
- sensitive components of the Instrument.
- 1808 Rationale: Preservation of Instrument cleanliness during Spacecraft I&T.
- 1809 9.7.3.2 Protective Covers: Documentation
- 1810 The CICD will document the requirements and procedures for the use of protective covers
- 1811 (such as bags, draping materials, or hardcovers).
- 1812 Rationale: Preservation of Instrument cleanliness during Spacecraft I&T.
- 1813 9.7.3.3 *Instrument Cleanliness Requirements*
- 1814 The CICD will document the cleanliness goals for all contamination-sensitive instrument
- 1815 surfaces that will be exposed while in the Integration and Test Environment.
- 1816 Rationale: Enables the Spacecraft Manufacturer and Instrument Provider to negotiate appropriate
- and reasonable instrument accommodations or determine the degree of deviation from the
- 1818 defined goals.
- 1819 9.7.4 Instrument Purge Requirements
- 1820 The CICD will document Instrument purge requirements, including type of purge gas, flow
- rate, gas purity specifications, filter pore size, type of desiccant (if any), and whether
- interruptions in the purge are tolerable.
- 1823 Rationale: The Spacecraft Manufacturer generally will provide access to a gas supply of the
- desired type, purity, and flow rate. The Instrument provider is responsible to provide the
- necessary purge interface ground support equipment (See 9.7.4.1).
- 1826 9.7.4.1 Instrument Purge Ground Support Equipment (GSE)
- 1827 The Instrument Provider should provide purge ground support equipment (GSE)
- incorporating all necessary filtration, gas conditioning, and pressure regulation
- 1829 capabilities.

Common II	Common Instrument Interface Project				
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Rationale: The Instrument provider is responduring Spacecraft Integration & Test. This and the gas supply provided by the Spacecraft	purge GSE is the interface between				
9.7.4.2 Spacecraft to Instrument Purge The MICD will document any required a between the Instrument and Spacecraft.	ů ,	rument purge			
Rationale: If the Instrument Purge requires a mechanical interface with the Spacecraft, that interface shall be documented in the MICD. The Spacecraft Manufacturer will negotiate with the Launch Vehicle Provider any resultant required purge interface between the Spacecraft and Launch Vehicle.					
9.7.4.3 Instrument Inspection and Clear The Instrument Provider should be respondent and Test Environment.	nning During I&T: Responsibility onsible for cleaning the Instrum	ent while in the			
Rationale: The Instrument Provider is responsible for completing any required inspections during I&T. The Instrument Provider may, upon mutual agreement, designate a member of the Spacecraft I&T team to perform inspections and cleaning.					
9.7.4.4 Instrument Inspection and Cleaning During I&T: Documentation The CICD will document any required inspection or cleaning of the Instrument while in the Integration and Test Environment.					
Rationale: Instrument inspections and clear conducted in coordination with other Space	_	and must be			
9.7.4.5 Spacecraft Contractor Supplied The CICD will document the expected Spacecraft Contractor Supplied Spacecraft Contractor Supplied The CICD will document the expected Spacecraft Contractor Supplied Spacecraft Contractor S	. 1	n environment.			
Rationale: Mitigate the risk of Instrument-S Contractor may perform analyses or make a contamination environment, which will be assessments may include a quantitative esti Instrument surfaces and be used to determine the Instrument.	documented in CICD. The results mate of the deposition of plume of	aft-induced s of such constituents to			
9.7.4.6 Launch Vehicle Contractor Sup The CICD will document the Launch Ve		vironment			
Rationale: Most Launch Vehicle Providers	are able to provide nominal infor	mation regarding the			

upper bound of molecular and particulate contamination imparted to the Spacecraft Payload

surfaces; frequently such information is found in published User Guides for specific Launch

Vehicles. Spacecraft and Instrument Providers should use this information in developing

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- mitigations against the risk of contamination during integrated operations with the Launch
- 1866 Vehicle.
- 1867 9.8 Model Guidelines and Submittal Details
- 1868 9.8.1 Finite Element Model Submittal
- 1869 The Instrument Developer should supply the Spacecraft Manufacturer with a Finite
- 1870 Element Model in accordance with the GSFC GIRD.
- 1871 Rationale: The GIRD defines a NASA Goddard-approved interface between the Earth Observing
- 1872 System Common Spacecraft and Instruments, including requirements for finite element models.
- As of the publication of this guideline document, Gird Rev B is current, and the Finite Element
- 1874 Model information is in Section 11.1.
- 1875 9.8.2 Thermal Math Model
- 1876 The Instrument Developer should supply the Spacecraft Manufacturer with a reduced
- 1877 node geometric and thermal math model in compliance with the following sections.
- 1878 Rationale: The requirements and details for the Thermal Model submittal listed in this section are
- based on commonly used NASA documents such as GSFC GIRD and JPL spacecraft instrument
- interface requirement documents.
- **1881** 9.8.2.1 *Model Format*
- Model format should be in Thermal Desktop version 5.2 or later or NX Space Systems Thermal
- version 7.x or later.
- 1884 9.8.2.2 *Units of Measure*
- 1885 Model units should be SI.
- 1886 9.8.2.3 Radiating Surface Element Limit
- 1887 Radiating surface elements should be limited to less than 200.
- 1888 9.8.2.4 Thermal Node Limit
- 1889 Thermal nodes should be limited to less than 500.
- 1890 9.8.2.5 *Model Verification*
- 1891 The Geometric Math Model and Thermal Math Model should be documented with a benchmark
- case in which the Spacecraft Developer may use to verify the model run.
- 1893 9.8.2.6 Steady-State and Transient Analysis
- 1894 The model should be capable of steady-state and transient analysis.
- 1895 9.8.2.7 Reduced Node Thermal Model Documentation
- 1896 The Instrument Provider should supply the Spacecraft Developer with documentation describing
- the reduced node thermal model. The documentation should contain the following:

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- **1898** 9.8.2.1.7 Node(s) Location
- 1899 The node(s) location at which each temperature limit applies.
- 1900 9.8.2.2.7 Electrical Heat Dissipation
- 1901 A listing of electrical heat dissipation and the node(s) where applied.
- 1902 9.8.2.3.7 Active Thermal Control
- 1903 A listing of active thermal control, type of control (e.g., proportional heater), and the node(s)
- where applied.
- 1905 9.8.2.4.7 Boundary Notes
- 1906 A listing and description of any boundary nodes used in the model.
- 1907 9.8.2.5.7 Environmental Heating
- 1908 A description of the environmental heating (Beta angle, heliocentric distance, planetary albedo,
- 1909 planetary emissive power, etc.).
- 1910 9.8.2.6.7 User Generated Logic
- 1911 A description of any user generated software logic
- 1912 9.8.3 Thermal Analytical Models
- 1913 The Instrument Provider should furnish the Spacecraft Manufacturer with a written report
- documenting the results of the detailed thermal analysis and the comparison of results to the
- reduced node model, including a high-level energy balance and heat flow map.
- 1916 9.8.4 Mechanical CAD Model
- **1917** 9.8.4.1 *Model Format*
- 1918 The Instrument Provider should provide Mechanical CAD models that have been created
- in a file format compatible with the spacecraft vendor, i.e. in the same program and version
- 1920 of the spacecraft vendor or in a neutral file format such as IGES or STEP.
- 1921 Rationale: The Spacecraft Manufacturer may need Mechanical CAD models for hosted payload
- 1922 assessment studies.
- 1923 9.8.5 Mass Model
- 1924 9.8.5.1 Instrument Mass Model
- 1925 The Instrument Provider should provide all physical mass models required for spacecraft
- 1926 mechanical testing.
- 1927 Rationale: The Spacecraft Manufacturer may fly the mass model in lieu of the Instrument in the
- 1928 event that Instrument delivery is delayed.

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1929 Appendix A Acronyms

Al&T Assembly, Integration, and Test

AP Average Power

ASD Acceleration Spectral Density

AWG American Wire Gauge

CCSDS Consultative Committee for Space Data Systems

CE Conducted Emissions
CICD Contamination ICD

CII Common Instrument Interface
COTS Commercial Off The Shelf
CS Conducted Susceptibility

CVCM Collected Volatile Condensable Material

DICD Data ICD

EED Electro-explosive Device
EICD Electrical Power ICD

EMC Electromagnetic Compatibility
EMI Electromagnetic Interference
EOS Earth Observing System
EPS Electrical Power System
ESA European Space Agency
EVI Earth Venture Instrument

FDIR Fault Detection, Isolation, and Recovery

FOV Field of View

GCR Galactic Cosmic Ray
GEO Geostationary Earth Orbit

GEVS General Environmental Verification Standard
GIRD General Interface Requirements Document

GOES Geostationary Operational Environmental Satellites

GSE Ground Support Equipment
GSFC Goddard Spaceflight Center
GTO Geostationary Transfer Orbit
HPO Hosted Payload Opportunity

HPOC Hosted Payload Operations Center HSOC Host Spacecraft Operations Center

I&T Integration and Test

IAC Interface Alignment Cube
ICD Interface Control Document

KDP Key Decision Point LEO Low Earth Orbit

LET Linear Energy Transfer

LVDS Low Voltage Differential Signaling

MAC Mass Acceleration Curve

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MICD Mechanical ICD
MLI Multi-layer Insulation

NDE Non-Destructive Evaluation
NICM NASA Instrument Cost Model
NPR NASA Procedural Requirement

NTIA National Telecommunications and Information Administration

OAP Orbital Average Power
PI Principal Investigator
PPL Preferred Parts List
RDM Radiation Design Margin
RE Radiated Emissions

RFI Request for Information
RS Radiated Susceptibility

RSDO Rapid Spacecraft Development Office

SEE Single Event Effect SI Système Internationale

SMC US Air Force Space and Missile Systems Center

SMC/XRFH SMC Hosted Payload Office

SPS Spectrum Planning Subcommittee

SRS Shock Response Spectrum
TEMP Test and Evaluation Master Plan

TICD Thermal ICD
TID Total lonizing Dose

TML Total mass Loss
VDC Volts Direct Current

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2013 2014	Orbital Sciences Corporation, <i>Minotaur IV</i> at: http://www.orbital.com/NewsInfo		•
2015 2016	Orbital Sciences Corporation, <i>Pegasus User</i> http://www.orbital.com/NewsInfo/Property		, available at:
2017 2018	Rapid III Contract Catalog, NASA Rapid S http://rsdo.gsfc.nasa.gov/catalog.htm	1 1	railable at:
2019 2020 2021 2022	Request for Information and Geostationary Accommodations, April 2012, availa https://www.fbo.gov/spg/NASA/Lal-Responses are proprietary.	ble at:	
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Appendix C Units of Measure and Metric Prefixes

2039 Table C-1: Units of Measure

Abbreviation	Unit
Α	ampere
Arcsec	arc-Second
В	bel
bps	bits per second
eV	electron-volt
F	farad
g	gram
Hz	hertz
J	joule
m	meter
N	newton
Pa	pascal
Rad [Si]	radiation absorbed dose = 0.01 J/(kg of Silicon)
S	second
T	tesla
Torr	torr
V	volt
Ω	ohm

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2038

Table C-2: Metric Prefixes

Prefix	Meaning
М	mega (10 ⁶)
k	kilo (10 ³)
d	deci (10 ⁻¹)
С	centi (10 ⁻²)
m	milli (10 ⁻³)
μ	micro (10 ⁻⁶)
n	nano (10 ⁻⁹)
р	pico (10 ⁻¹²)

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Appendix D CII Hosted Payload Concept of Operations 2043 2044 **D.1 INTRODUCTION** This CII Hosted Payloads Concept of Operations (CONOPS) provides a prospective Instrument 2045 2046 Developer with technical recommendations to help them design an Instrument that may be flown 2047 as a hosted payload either in LEO or GEO. This document describes the systems, operational 2048 concepts, and teams required to develop, implement, and conduct a hosted payload mission. More specifically, this CONOPS document primarily supports stakeholders involved in NASA 2049 Science Mission Directorate (SMD) Earth Science Division's investigations. What follows is a 2050 CONOPS applicable to those ESD payloads to be hosted as a secondary payload, including those 2051 2052 developed under the EVI solicitation. 2053 D.1.1 Goals and Objectives 2054 The CONOPS documents the functionality of a hosted payload mission and defines system segments, associated functions, and operational descriptions. The CONOPS represents the 2055 2056 operational approaches used to develop mission requirements and provides the operational 2057 framework for execution of the major components of a hosted payload mission. 2058 The CONOPS is not a requirements document, but rather, it provides a functional view of a 2059 hosted payload mission based upon high-level project guidance. All functions, scenarios, 2060 figures, timelines, and flow charts are conceptual only. 2061 D.1.2 **Document Scope** 2062 The purpose of this CONOPS)document is to give an overview of LEO and GEO satellites 2063 operations, with an emphasis on how such operations will impact hosted payloads. 2064 This CONOPS is not a requirements document and will not describe the Instrument Concept of 2065 Operation in detail or what is required of the Instrument to operate while hosted on LEO/GEO 2066 satellites 2067 D.2 COMMON INSTRUMENT INTERFACE PHILOSOPHY 2068 This CONOPS supports the "Do No Harm" concept as described in section 2.2.1. 2069 D.3 LEO/GEO SATELLITE CONCEPT OF OPERATIONS SUMMARY

2073 D.3.1 General Information

2070

2071

2072

This section is intended to be a summary of the Concept of Operations for both Low Earth Orbit

Satellites [LEO] and Commercial Geostationary Communications Satellites [GEO], to give the

Instrument provider an idea of what to expect when interfaced to the Host Spacecraft.

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[LEO] Nominal Orbit: The Host Spacecraft will operate in a Low Earth Orit with an altitude between 350 and 2000 kilometers with eccentricity less than 1 and inclination between zero and 180°, inclusive (see section 2.1.3). LEO orbital periods are approximately 90 minutes.

[LEO] The frequencies used for communicating with LEO spacecraft vary, but S-Band (2–4 GHz) with data rates up to 2 Mbps are typical. Since communication with ground stations requires line-of-site, command uplink and data downlink are only possible periodically and vary considerably depending on the total number of prime and backup stations and their locations on Earth. Communication pass durations are between 10–15 minutes for a minimum site angle of 10°.

[GEO] Nominal Orbit: The Host Spacecraft will operate in a Geostationary Earth Orbit with an altitude of approximately 35786 kilometers and eccentricity and inclination of approximately zero (see section 2.1.2.) GEO satellites remain in the same fixed location over the ground location for the life of the mission. Station keeping is required on a regular basis to maintain that fixed position. Current commercial communication satellite locations are as shown in Figure D-1. If full continental United States coverage is desired, a location of around 95°W - 100°W may be desired as shown in Figure D-2.

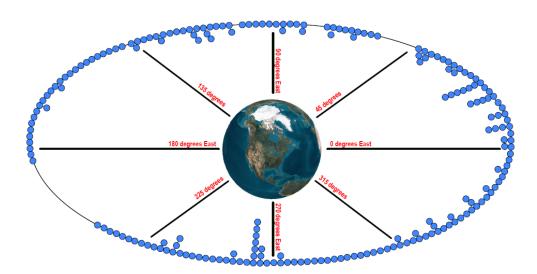


Figure D-1: Geostationary Locations

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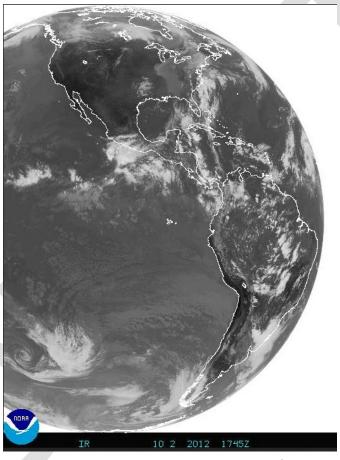


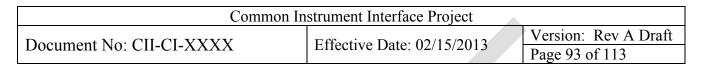
Figure D-2: GOES-14 Image at 100°W

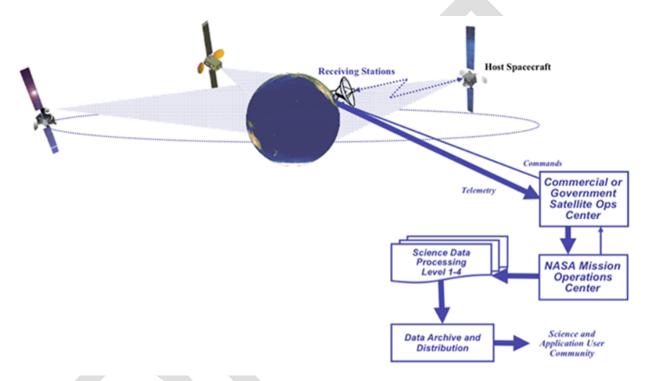
[GEO] The Instrument approach provides the advantage of utilizing the Commercial Satellite's location, features, and services. Due to the location, the Instrument will have minimal data latency due to continuous real-time bi-directional communications links. As older commercial communications satellites are going out of service, newer more sophisticated satellites are replacing them.

data services from the Host Spacecraft or provide their own. The Instrument will have continuous direct data transfer to/from the Host Spacecraft during normal operations. The Instrument will have continuous direct data broadcast with the ground via the Host Spacecraft

[GEO] The Instrument will have the option to either purchase command and/or telemetry and/or

ground system during normal operations, as shown in Figure D-3.





D.3.2 Phases of Operation

The Host Spacecraft will have numerous phases of operation, which can be described as launch & ascent, [GEO] Geostationary Transfer Orbit (GTO), checkout, normal operations, and safehold. The Instrument will have similar phases that occur in parallel with the Host Spacecraft. A summary of the transition from launch to normal operations is as shown in Figure D-4.

Figure D-3: Ground System Interfaces

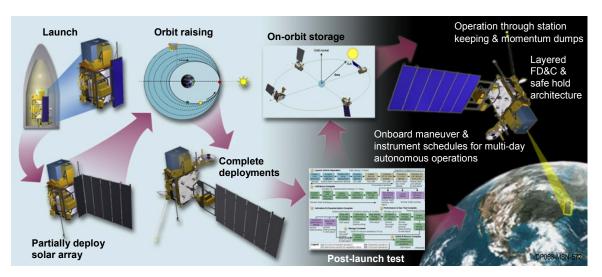


Figure D-4: Summary of Transition to Normal Operations

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- 2114 Launch and Ascent
- 2115 During this phase, the satellite is operating on battery power and is in a Standby power mode,
- 2116 minimal hardware is powered on, e.g., computer, heaters, RF receivers, etc.
- Heaters, the RF receiver and the satellite computer will be powered on collecting limited health
- 2118 and status telemetry and when the payload fairing is deployed, the RF transmitter may
- 2119 automatically be powered on to transmit health and status telemetry of the satellite, this is vendor
- 2120 specific.
- 2121 Instrument Launch and Ascent
- 2122 The Instrument will be powered off, unless it is operating on its own battery power and the Host
- 2123 Spacecraft has agreed to allow it to be powered. No commutations between the Instrument and
- 2124 the Host Spacecraft or the ground (in the event the Instrument has a dedicated RF transponder)
- 2125 will take place. The Host Spacecraft may provide survival heater power to the Instrument during
- 2126 this phase, as negotiated with the Host Spacecraft.
- 2127 Orbit Transfer ([GEO] GTO)
- 2128 [GEO] During this phase, the satellite is in transition to its orbital location and will take several
- 2129 days, depending on the method of transfer and the propulsion. Conventional propulsion systems
- 2130 can take up to 10 days, while electric propulsion systems can take up to 6 months. Typically,
- 2131 prior to the first burn, the solar array is partial deployed to allow more satellite hardware to be
- powered, provide power to the electric propulsion system if used and charge the batteries, as
- 2133 shown in Figure D-4.
- 2134 [LEO] The satellite will be injected directly into its orbit location as part of the launch and
- ascent phase.
- 2136 Instrument Orbit Transfer
- 2137 The Instrument will be powered off and no commutations between the Instrument and the Host
- 2138 Spacecraft or the ground (in the event the Instrument has a dedicated RF transponder) will take
- 2139 place, unless negotiated otherwise with the Host Spacecraft due to the science data to be
- 2140 collected. If the Instrument is powered off, the Host Spacecraft will provide survival heater
- 2141 power, as negotiated.
- 2142 If the Instrument is powered on during this phase, the Host Spacecraft will provide primary
- 2143 power as negotiated.
- 2144 On-Orbit Storage
- 2145 [GEO] The satellite may inject into a storage location to either perform its checkout or if the
- 2146 operational satellite hasn't been decommissioned. The checkout for the Host Spacecraft as well
- 2147 as the instrument will be performed at this location. At the appointed time, the satellite will
- 2148 perform a series of maneuvers to re-locate to the operational location.
- 2149 [LEO] An on-orbit storage location may be used if the Host Spacecraft is part of a constellation
- and the current operational spacecraft hasn't been decommissioned. The satellite may inject into
- 2151 this location to perform its checkout, as will the instrument. Upon completion of the checkout or

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- 2152 if the operational satellite has been decommissioned, the Host Spacecraft will perform a series of 2153 maneuvers to re-locate into its location within the constellation. Checkout 2154 2155 After orbit transfer and the final burn is completed and the orbital location has been successfully 2156 achieved, full solar array deployment will take place and the satellite check process will begin. 2157 Each subsystem will be fully powered and checked out in a systematic manor. Once the satellite 2158 is successfully checked-out and operational, the communication payload checkout begins, also in 2159 a systematic manor. When both the satellite and communications payload are successfully 2160 checked-out, the owner/operator will transition to normal operations. 2161 **Normal Operations** The satellite is in this phase as long as all hardware and functions are operating normally and 2162 2163 will remain in this phase for the majority of its life. 2164 Once the transition to normal operations is achieved, only then is the hosted payload powered on 2165 and the checkout process begun. 2166 Instrument Checkout 2167 After the Host Spacecraft has achieved normal operations, the Instrument will be allowed to 2168 power on and begin its checkout process. Calibration of the Instrument would be during this 2169 phase as well. Any special maneuvering required of the Host Spacecraft will be negotiated. 2170 *Instrument Normal Operations* 2171 The Instrument will remain in this phase as long as all hardware and functions are operating 2172 normally and will remain in this mode for the majority of its life. 2173 Safehold 2174 While not technically an operational phase, this mode is achieved when some sort of failure of the Host Spacecraft has occurred. This mode can be achieved either autonomously or manually. 2175 2176 During this mode, all non-essential subsystems are powered off, the communications payload 2177 maybe powered off, depending on the autonomous trigger points programmed in the flight
- 2181 After the failure has been understood and it is safe to do so, the owner/operator Mission
- 2182 Operations Center will transition the Host Spacecraft back to normal operations. After normal

software, the hosted payload will be powered off, and the satellite will be maneuvered into a

power-positive position. When the Host Spacecraft enters Safehold the Instrument may be

operations have been achieved, the hosted payload will be powered back on.

commanded into Safehold, but will most likely be powered-off.

2184 Instrument Safehold

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- 2185 The Instrument will go into this mode one of two ways, either due to a Host Spacecraft failure or
- 2186 an Instrument failure. In the event the Host Spacecraft experiences a failure, the Host Spacecraft
- will immediately cut the power to the Instrument and the Instrument will have to be able to
- 2188 successfully recover from this event.

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2189 In the event the Instrument experiences a failure of some sort, it will have to autonomously move 2190 into this mode without manual intervention. The Instrument Mission Operations Center will 2191 manually perform the trouble shooting required and manually transition the Instrument back to 2192 normal operations. Instrument Safehold Recovery 2193 2194 If Host Spacecraft operations require the Instrument to be powered off with no notice, the 2195 Instrument must autonomously recover in a safe state once power has been restored. Once health 2196 and status telemetry collection and transmission via the Host Spacecraft has been restored, the 2197 Instrument operations center may begin processing data. 2198 Host Spacecraft Normal Operations After Instrument End of Life 2199 Commercial spacecraft are designed to have operational lifetimes of typically less than 10 years 2200 in LEO, while GEO lifetimes of 15 years or more are common. Instrument lifetimes are 2201 prescribed by their mission classification (Class C, no more than 2 years). The Instrument lifetime may be extended due to nominal performance and extended missions may be negotiated 2202 2203 (Phase E). Since the Host Spacecraft may outlive the Instrument, especially commercial GEO 2204 satellites, the Instrument must be capable of safely decommissioning itself. 2205 During the end of life phase, the Instrument will be completely unpowered, unless survival 2206 heaters are required to assure host satellite safety, and, essentially, inert. This may involve the locking of moving parts and the discharge of any energy or consumables in the payload. This 2207 2208 process will be carried out such that it will not perturb the Host Spacecraft in any way. Upon 2209 completion, the Host Spacecraft will consider the Instrument as a simple mass model that does 2210 not affect operations. 2211 De-commissioning 2212 At the end of the Host's mission life, it will perform a series of decommissioning maneuvers to 2213 de-orbit to clear the geostationary location. The Instrument will have been configured into the lowest possible potential energy state and then powered down at the end of its mission. The host 2214 2215 maneuvers may span several days to relocate where it will be powered down and its mission life 2216 will end. 2217 D.4 HOSTED PAYLOAD OPERATIONS 2218 The Host Spacecraft will have a primary mission different than that of the Instrument. The 2219 Instrument's most important directive is to not interfere or cause damage to the Host Spacecraft 2220 or any of its payloads, and to sacrifice its own safety for that of the Host Spacecraft. 2221 The Host Spacecraft has priority over the Instrument. Special or anomalous situations may 2222 require temporary suspension of Instrument operations. Instrument concerns are always 2223 secondary to the health and safety of the Host Spacecraft and the objectives of primary payloads. 2224 Suspension of Instrument operations may include explicitly commanding the Instrument to Safe 2225 mode or powering it off. The Host Spacecraft operator may or may not inform the Instrument

operators prior to suspension of operations.

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2227 **D.4.1** Instrument Modes of Operation

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Table D-1 shows the command and control responsibilities of the commercial Host Spacecraft Operations Center (HSOC) and Hosted Payload Operations Center (HPOC) for hosted payload missions. Hosted payload power control will be performed by HSOC commands to the commercial satellite with hosted payload commanding performed by the HPOC after power is enabled. Operation of the hosted payload will be performed by the HPOC. In case of any space segment anomalies, the HSOC and HPOC will take corrective actions with agreed upon procedures and real-time coordination by the respective control teams.

Table D-1:GEO/LEO Instrument Operating Modes Based Upon Mission Phase

Instrument Mission Phase	Launch	Orbit Transfer	On Orbit Storage	Checkout	Nominal Operations	Anomalous Operations	End of Life
Survival Power	OFF/ON	On	On	On	On	On	On/Off
Instrument Power	OFF	OFF	OFF	OFF/ON	On	On	On/Off
Mode	OFF/ SURVIVAL	OFF/ SURVIVAL	OFF/ SURVIVAL	INITIALIZE/ OPERATION/ SAFE	OPERATION	Safe	SAFE/ OFF/ SURVIVAL
Command Source	NA	NA	NA	HPOC	HPOC	HPOC	HPOC/ NA
Note: Host Spacecraft controls Instrument power.							

The following are a set of short descriptions of each of the basic modes of operation. A more detailed set of guidance regarding these basic modes and transitions may be found in Appendix G.

2239 OFF/SURVIVAL Mode

2240 In the OFF/SURVIVAL Mode, the Instrument is always unpowered and the instrument survival 2241 heaters are in one of two power application states. In the survival heater OFF state of the 2242 OFF/SURVIVAL mode, the survival heaters are unpowered. In the survival heater ON state of the 2243 OFF/SURVIVAL Mode, the survival heaters are powered. The spacecraft should verify that the 2244 power to the survival heaters is enabled after the command to enter the survival heater ON state 2245 of the Off/Survival mode has been actuated. Nominal transitions into the Off/Survival mode 2246 are either from the Initialization mode, the SAFE mode or the Operation mode with the 2247 preferred path being a transition from the SAFE mode. The only transition possible out of the 2248 OFF/SURVIVAL mode is into the INITIALIZATION mode.

It is important to note that the Instrument should be capable of withstanding a near instantaneous transition into the OFF/SURVIVAL mode at any time and from any of the other three Instrument modes. Such a transition may be required by the Spacecraft host and would result from the sudden removal of operational power. This could occur without advance warning or notification and with no ability for the Instrument to go through an orderly shutdown sequence. This sudden removal of instrument power could also be coupled with the near instantaneous activation of the survival heater power circuit(s).

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2256 Initialization Mode

- When first powered-on, the Instrument transitions from the OFF/SURVIVAL mode to the Initialization mode and conducts all the internal operations that are necessary in order to
- transition to the OPERATION mode or to the SAFE mode. These include, but are not limited to,
- activation of command receipt and telemetry transmission capabilities, initiation of health and status telemetry transmissions and conducting instrument component warm-up/cool-down to
- 2262 nominal operational temperatures. The only transition possible into the INITIALIZATION mode is
- from the Off/Survival mode. Nominal transitions out of the Initialization mode are into the
- 2264 OFF/SURVIVAL mode, the SAFE mode or the OPERATION mode.

2265 OPERATION Mode

- 2266 The Instrument should have a single OPERATION mode during which all nominal Instrument
- operations occur. It is in this mode that science observations are made and associated data are
- 2268 collected and stored for transmission at the appropriate time in the spacecraft operational
- timeline. Within the OPERATION mode, sub-modes may be defined that are specific to the
- particular operations of the Instrument (e.g. STANDBY, DIAGNOSTIC, MEASUREMENT, etc.).
- When the Instrument is in the OPERATION mode, it should be capable of providing all health and
- status and science data originating within the instrument for storage or to the Spacecraft for
- transmission to the ground operations team. Nominal transitions into the OPERATION mode are
- 2274 either from the INITIALIZATION mode or the SAFE mode. Nominal transitions out of the
- 2275 OPERATION mode are into either the OFF/SURVIVAL mode or the SAFE mode.

2276 SAFE Mode

- The Instrument SAFE mode is a combined Instrument hardware and software configuration that is
- 2278 intended to protect the Instrument from possible internal or external harm while using a
- 2279 minimum amount of Spacecraft resources (e.g. power). When the instrument is commanded into
- 2280 SAFE mode, it should notify the Spacecraft after the transition into this mode has been
- 2281 completed. Once the Instrument is in SAFE mode, the data collected and transmitted to the
- 2282 HPOC should be limited to health and status information only. Nominal transitions into the
- 2283 SAFE mode are either from the INITIALIZATION mode or the OPERATION mode. Nominal
- 2284 transitions out of the SAFE mode are into either the OFF/SURVIVAL mode or the OPERATION
- 2285 mode.

2286 D.4.2 Instrument Interfaces

- The instrument should refer to the referenced Guidelines document for all Instrument/Host
- 2288 Spacecraft interfaces.
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Appendix E Supporting Analysis for LEO Guidelines

 In order to provide Level 1 guidelines for future hosted payload instruments, we have examined the NASA Instrument Cost Model (NICM) remote sensing database to identify instrument characteristic parameters. The database has information on 102 different instruments that launched before 2009 from all four divisions of the Science Mission Directorate (SMD), as depicted in Table E-1. There are two significant characteristics of the data set that limit its statistical power to draw conclusions about Earth Science instruments. The first is the small sample size of Earth Science instruments (n=28). The second is that since more than half of the NICM instruments are Planetary, which tend to be smaller overall, the data are skewed. Nonetheless, analyzing the entire 102-instrument set provides some useful insight.

Table E-1: Distribution of NICM Instruments Among Science Mission Directorate Divisions

	SMD Division	Directed	Competed	Non-NASA	Total
	Earth	18	5	5	28
	Planetary	35	18	1	54
	Heliophysics	5	3	1	9
1	Astrophysics	10	1	0	11
	Total	68	27	7	102

In analyzing the data, one may easily conclude that the development cost of an instrument is a function of multiple parameters such as: mass, power, data rate, year built, SMD division and acquisition strategy. With further analysis, one will realize that these parameters are not independent of each other and are implicitly functions of mass. For example, Planetary Science instruments tend to be smaller than Earth Science instruments, and competed instruments tend to be smaller than their directed counterparts. As technology improves with time, the instruments get smaller and more capable. With this information, we have plotted the instrument cost as a function of mass as shown in Figure E-1.

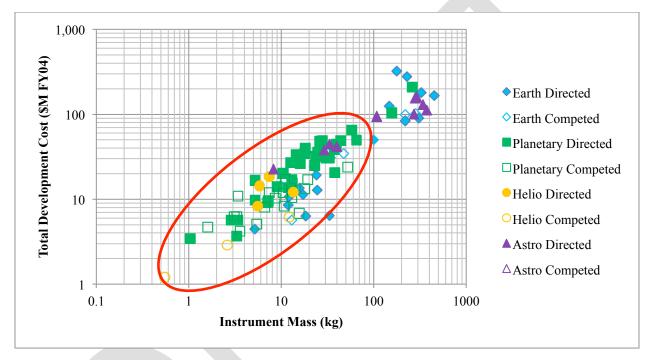


Figure E-1: Instrument Mass vs. Development Cost

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In further examination of the data, specifically the Earth Science instruments that are outside the ellipse in Figure E-1, one realizes that they were primary instruments that the mission were built around, for example, the Aura mission with the MLS and TES instruments. Given that this document deals with instruments that are *classified as hosted payloads* without knowledge of what mission or spacecraft they will be paired with, the CII WG *allocates 100 kg for the Level 1 mass guideline.* Therefore, every effort should be made to keep the mass to less than 100 kg to increase the probability of matching up with an HPO.

Figure E-2 shows the relationship between power and mass. The power consumed by an instrument is also approximately linearly correlated to the mass of the instrument. On this basis, we allocate 100 W for the Level 1 power guideline for a 100 kg instrument.

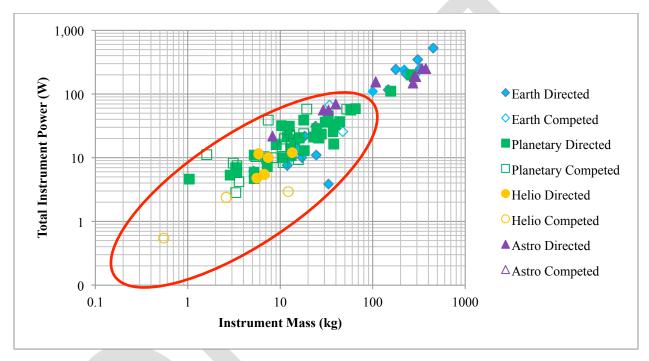


Figure E-2: Power as a Function of Mass

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As stated earlier, instruments over time have become smaller and more capable. Specifically, in Earth Science instruments this translates into generating more and more data. Figure E-3 shows the data rates for all SMD instruments. This graph indicates that the data rate has increased by about an order of magnitude over two decades. Based upon this observation *we set the Level 1 data rate guideline at 10 Mbps*. It is clear that some instruments will generate more than 10 Mbps. This implies that the instruments should have the capability of on-board data analysis and or data compression or the capability of fractional time data collection. As with all guidelines contained within this document, once the instrument is paired with an HPO, the agreement between the two will supersede these guidelines.

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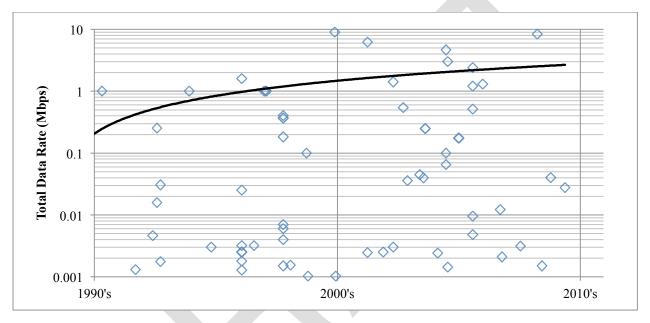


Figure E-3: Trend of Mean Instrument Data Rates

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Categorization of the instruments as hosted payloads implies that these instruments have a mission risk level of C as defined in NPR 8705.4. This in turn defines the 2-year operational life and software classification.

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2338 Appendix F Supporting Analysis for GEO Guidelines

- 2339 On 29 March 2012, NASA Langley Research Center released a Request for Information (RFI)
- for Geostationary Earth Orbit (GEO) Hosted Payload Opportunities (HPO) and
- 2341 Accommodations, upon whose responses the CII Team primarily established our GEO
- 2342 guidelines.
- 2343 NASA Langley Research Center is hereby soliciting information
- 2344 about potential sources for Geostationary Earth Orbit (GEO)
- 2345 Hosted Payload Opportunities (HPO) and Accommodations.

2346 Background

- 2347 NASA's Earth Science Division (ESD) will be developing Earth
- 2348 Science Instruments, some of which may be suitable to fly as
- 2349 hosted payloads on HPO's. The development of the instruments as
- 2350 well as the HPO's will be conducted independently of each other
- 2351 with the goal of matching a specific instrument with a specific
- 2352 HPO by the instrument Preliminary Design Review (PDR) timeframe.
- 2552 HPO by the instrument Preliminary Design Review (PDR) timeliame
- 2353 In an effort to facilitate matching instruments to HPO's, ESD
- 2354 initiated the Common Instrument Interface (CII) Project. The
- 2355 charter for the CII Project is to work with industry, academia,
- 2356 and other governmental agencies to develop a set of common
- 2357 instrument-to-spacecraft interfaces that could serve as
- 2358 quidelines for instrument developers. If used properly by
- 2359 instrument developers, these guidelines would help produce
- 2360 instruments that have a less complex interface and would improve
- 2361 the probability of matching a given instrument with a HPO or
- 2362 platform.
- 2363 The CII Project has recently completed a draft set of Low Earth
- 2364 Orbit (LEO) guidelines and a draft HPO Database document.
- 2365 Additional information on the CII project may be found at this
- 2366 website: http://science.nasa.gov/about-us/smd-programs/earth-
- 2367 system-science-pathfinder/common-instrument-interface-workshop/.
- 2368 Current CII Guideline and HPO database documents may be found on
- 2369 the Earth Venture Instruments 1 Program Library:
- 2370 http://essp.larc.nasa.gov/EV-I/evi programlibrary.html

2371 Current Intention

- 2372 The CII Project is now interested in identifying HPO's, and
- 2373 their associated accommodations, for future GEO missions in
- 2374 order to develop a draft set of GEO guidelines to complement our
- 2375 LEO guidelines, and to update the publically-available HPO
- 2376 database document. Additionally, the CII Project is
- 2377 investigating flying and operating a hosted payload on an
- 2378 upcoming GEO HPO as a pathfinder initiative (hereafter described
- 2379 as the "Initiative") to better understand the programmatic and

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technical challenges for a commercially-hosted NASA science payload. The CII Project would document lessons learned from conducting the GEO pathfinder initiative and feed them back into the GEO guidelines document to help developers intending to fly a payload on a future GEO HPO.

The purpose of this RFI is to:

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- 1) Identify the GEO HPO's for the period from 2013-2023;
- 2) Obtain a description of available HPO payload accommodations on future GEO HPO's; and
- 3) Obtain information on all of the steps required to fly the "Initiative" as described later in this RFI.

The CII Project can accommodate responses containing properly-marked proprietary information. The CII Project will safeguard the proprietary information on hosted payload opportunities (Requested Information #1) and payload accommodations (Requested Information #2) within the Project organization. The CII Project intends to utilize the non-proprietary portions of Requested Information #1 to update the publicly available HPO database. The CII Project intends to use Requested Information #2 to bound/envelope the payload accommodation parameters that will inform the future GEO Guidelines Document. NASA may also use Requested Information #1 and #2 to assess the suitability of hosted payload-to-spacecraft matches associated with future NASA Earth Science missions.

The CII Project will use the requested information for the GEO pathfinder initiative (Requested Information #3 above) to assess the feasibility of such an Initiative, to provide an overview of the hosted payload process in the future GEO Guidelines

Document, and to inform future Earth Science hosted payload planning and programming activities.

Requested Information

- 2411 1. Please identify your organization's HPO's for the period of 2412 2013-2023 with their associated mission parameters including but not limited to:
- 2414 Mission Name
- 2415 Launch Date
- Owner/Operator
- 2417 Primary Customer
- Spacecraft Bus Manufacturer
- Spacecraft Bus Model
- 2420 Launch Vehicle
- Orbital Longitude

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2422 If the data are not available beyond your current business 2423 cycle, please suggest a technique for the CII Project to obtain 2424 those data once they do become available.

- 2. Please describe what Payload Accommodation and Interface resources your HPO's can provide to a prospective hosted payload without significant modifications to your nominal manufacturing, integration, test and launch processes. Please also describe the environment the prospective hosted payload might expect to encounter:
 - Payload Accommodation Parameters and Interface
 - Maximum Payload Mass Available without System Redesign [kg]
 - Maximum Payload Orbital Average Power without System Redesign [W]
 - Maximum Payload Peak Power without System Redesign[W]
 - Main Bus Nominal Voltage [V]
 - O Volume (1 x w x h) [mm x mm x mm]
 - Sensor Mounting Location on Spacecraft (e.g. Nadir, Zenith, Ram, Wake, North, South, East, West, ...)
 - Command and Control Interface (1553B, RS-422, SpaceWire, etc.) with average and peak data rates [kbps]
 - Payload-to-Transponder Interface (RS-422, SpaceWire, etc.) for Science Data Transmission with average and peak data rates [Mbps]
 - Host spacecraft constraints or preferences for digital formats most suitable for conversion to RF in system architecture
 - o Payload command and control encryption requirements
 - o Pointing Control [arcsec]
 - o Pointing Knowledge [arcsec]
 - o Pointing Stability [arcsec / sec]
 - Spacecraft absolute position accuracy, each axis [m]
 - Spacecraft absolute velocity accuracy, each axis [m/s]
 - Limitations with respect to payload-induced uncompensated torques [N x m] by frequency [Hz]
 - Limitations with respect to payload-induced uncompensated forces [N] by frequency [Hz]
 - Typical Integration and Test Facility Cleanliness [Cleanroom Class]
 - o Thermal Rejection With Heat Pipes [W]
- 2463 o Thermal Rejection Without Heat Pipes [W]

2465 • Payload Environment

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o Temperature Range

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- 2467 o Ouasi-static loads
- 2468 o Minimum resonant frequency
- 2469 o Random vibration and acoustic loads
 - Shock environment
 - Disturbance torque
 - o RF Field EMI/EMC/ESD
- 2473 o Molecular contamination as a function of mission elapsed time and hosted payload location

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- 3. As a specific potential near term opportunity, please provide information on all of the programmatic and technical steps required to fly a GEO Pathfinder Initiative on your HPO's as described below.
- 2480 GEO Pathfinder Initiative Information
- 2481 The Initiative will also provide NASA with experience with the 2482 commercially-hosted payload process. The Initiative will also 2483 mitigate space environmental risks to future GEO missions by 2484 measuring vibration and contamination of an Instrument Suite 2485 hosted on a commercial GEO spacecraft. Both objectives will 2486 reduce risk on future commercially-hosted GEO Earth Science 2487 missions. See attached Figure 1 for an example of a notional 2488 Instrument Suite, which the CII Project will develop and
- 2488 Instrument Suite, which the CII Project will develop and 2489 provide, with the following characteristics:
- 2490 Mass: 50 kg
- 2491 Power: 125 W
 - Volume: 1000 x 500 x 500 mm
- 2493 Data Rate: 60 Mbps
- Thermal Control: Electronics thermally isolated, with exterior boxes insulated with multi-layer insulation (MLI).
 - The Instrument Suite is presumed to be mounted on the host spacecraft nadir deck.
 - The Instrument Suite has a nominal operational lifetime of 3 years

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- 2501 Note: The Initiative is designed to exercise the GEO hosted 2502 payload process whose parameters are a subset and likely smaller 2503 than those of a typical future science flight mission.
- 2504 GEO Pathfinder Initiative Requested Information
- 2505 Please provide information related to the accommodation of the 2506 Instrument Suite by your mission:
- Date the contract needs to be signed relative to Launch
 Date

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- Government-provided technical / programmatic deliverables required (e.g. mass and thermal models)
 - Instrument Suite delivery date required relative to Launch Date
 - Rough Order of Magnitude Price Estimate to fly and operate the Initiative. In addition to the Total price, please estimate the following components:
 - o Integration, Test, and Launch
 - Operations

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- Any concerns with FAR Part 12 terms and conditions: https://acquisition.gov/far/html/FARTOCP12.html
- Concept of operating hosted payload, including communications architecture
- Safety and mission assurance requirements levied upon hosted payload
- The level of NASA participation allowed during spacecraft development and instrument integration (e.g. spacecraft design reviews, environmental tests, etc.)

NASA is seeking capability statements from all interested parties, including Small, Small Disadvantaged (SDB), 8(a), Woman-owned (WOSB), Veteran Owned (VOSB), Service Disabled Veteran Owned (SD-VOSB), Historically Underutilized Business Zone (HUBZone) businesses, and Historically Black Colleges and Universities (HBCU)/Minority Institutions (MI) for the purposes of determining the appropriate level of competition and/or small business subcontracting goals.

- No solicitation exists; therefore, do not request a copy of the solicitation. If a solicitation is released it will be synopsized in FedBizOpps and on the NASA Acquisition Internet Service. It is the potential offeror's responsibility to monitor these sites for the release of any solicitation or synopsis.
- Vendors having the capabilities necessary to meet or exceed the stated requirements are invited to submit appropriate
- 2544 documentation, literature, brochures, and references.
- 2545 Please advise if the requirement is considered to be a 2546 commercial or commercial-type product. A commercial item is defined in FAR 2.101.
- This synopsis is for information and planning purposes and is not to be construed as a commitment by the CII Project nor will the CII Project cover any costs for information submitted in response to the RFI.

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2552 Technical questions should be directed to Craig Jones at 2553 Craig.D.Jones@nasa.gov. All other questions should be directed 2554 to Brad Gardner at Robert.B.Gardner@nasa.gov. All responses 2555 shall be submitted to Brad Gardner at Robert.B.Gardner@nasa.gov 2556 and to Craig Jones at Craig.D.Jones@nasa.gov no later than May 2557 11, 2012. Respondents may e-mail files up to 10MB in size to 2558 Brad Gardner; respondents shall submit larger files on optical 2559 storage media (CD/DVD) via postal mail to the following address: 2560 Brad Gardner 2561 Office of Procurement 2562 Building 2101, MS 12 2563 NASA Langley Research Center 2564 Hampton, VA 23681 2565 Please reference CII-GEO in any response.

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2566 Appendix G Instrument Modes

This section shows one way to set up a notional Instrument mode scheme and also provides context for those guidelines, especially data and electrical power, which reference various modes

2570 G.1 MODE GUIDELINES

2571 Basic Modes

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2572 Instruments should support four basic modes of operation: OFF/SURVIVAL, INITIALIZATION,

2573 OPERATION, and SAFE (see Figure G-1). Within any mode, the Instrument may define additional

sub-modes specific to their operation (e.g. STANDBY, DIAGNOSTIC, MEASUREMENT, etc.).

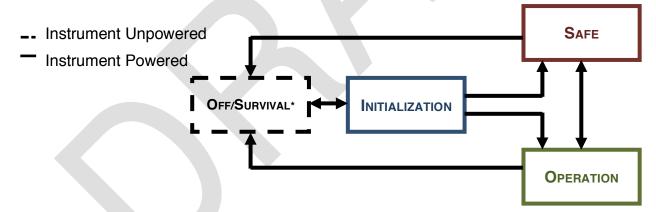


Figure G-1: Instrument Mode Transitions

2577 OFF/SURVIVAL Mode, Survival Heater OFF State

The Instrument is unpowered, and the survival heaters are unpowered in survival heater OFF

2579 state of the OFF/SURVIVAL mode

2580 OFF/SURVIVAL Mode Power Draw

The Instrument should draw no operational power while in OFF mode.

2582 Instrument Susceptibility to Unanticipated Power Loss

2583 The Instrument should be able to withstand the sudden and immediate removal of operational

power by the Spacecraft at any time and in any instrument mode. This refers specifically to the

sudden removal of operational power without the Instrument first going through an orderly

shutdown sequence.

2587 OFF/SURVIVAL Mode, Survival Heater On State

2588 The Instrument is unpowered, and the survival heaters are powered-on in the survival heater ON

state of the Off/Survival mode.

2590 Spacecraft Verification of Instrument Survival Power

2591 The Spacecraft should verify Instrument survival power is enabled upon entering the survival

2592 heater On state of the Off/Survival mode.

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Post-Launch Instrument Survival Circuit The Spacecraft should enable power to the seconds after spacecraft separation from the survival. The amount of time defined from survival heater circuit should be reviewed mission CONOPS, spacecraft and launch	e Instrument survival heater circuithe launch vehicle, unless preclude m spacecraft separation to enabling and revised as necessary after particular to the survival and revised as necessary after particular to the survival and revised as necessary after particular to the survival and revised as necessary after particular to the survival and revised as necessary after particular to the survival heater circuit and the survival heater circuit an	it(s) within 60 ed by Spacecraft g of the instrument
Instrument Susceptibility to Unanticipated The Instrument should be able to withstar OFF/SURVIVAL mode by the Spacecraft at specifically to the sudden removal of open through an orderly shutdown sequence an circuit(s).	nd the sudden and immediate trans any time and in any Instrument mational power without the Instrument	node. This refers nent first going
INITIALIZATION Mode When first powered-on, the Instrument en operations necessary in order to eventuall		
Power Application The Instrument should be in INITIALIZATION	ON mode upon application of elect	crical power.
Thermal Conditioning When in INITIALIZATION mode, the Instru or cool-down to operating temperatures.	ment should conduct Instrument c	omponent warm-up
Command and Telemetry When in INITIALIZATION mode, the commbe powered up first.	nand and telemetry functions of the	e Instrument should
Health and Status Telemetry When in Initialization mode, the Instrutelemetry.	ment should send the Spacecraft h	nealth and status
OPERATION Mode The Instrument OPERATION mode covers observations.	all nominal Instrument operations	and science
Science Observations and Data Collection. The Instrument should have one OPERATION Within the OPERATION mode, an instrument	ON mode for science observations	

 Data Transmission

ground operations team.

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When in OPERATION mode, the Instrument should be fully functional and capable of providing

all health and status and science data originating within the instrument to the Spacecraft and

operation (e.g. Standby, Diagnostic, Measurement, etc.).

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Resources When in OPERATION mode, the Instrument savailable to it.	should have all allocated Spacecra		
SAFE Mode The Instrument SAFE mode is a combined Ir to protect the Instrument from possible inter Spacecraft resources (<i>e.g.</i> power).			
Data Collection and Transmission When in SAFE mode, the Instrument should limit data collection and transmission to health and status information only.			
Notification The Instrument should notify the Spacecraft	when it has completed a transition	on to SAFE mode.	
G.2 MODE TRANSITIONS			
Impacts to other instruments and the Host S The Instrument should transition from its cu other instruments, or the Host Spacecraft bu	rrent mode to any other mode with	thout harming itself,	
Preferred Mode Transitions The Instrument should follow the mode transitions depicted in Figure G-1. The preferred transition to OFF/SURVIVAL mode is through SAFE mode. All other transitions to OFF/SURVIVAL are to be exercised in emergency situations only.			
SURVIVAL Mode Transitions Trigger The Spacecraft should transition the Instrum Spacecraft emergency.	nent to Off/Survival mode in the	e event of a severe	
Instrument Operational Power The Spacecraft should remove Instrument of	perational power during transition	n to Off/Survival	

INITIALIZATION Mode Transitions

Instrument Notification

2662 The Instrument should transition from OFF mode to INITIALIZATION mode before entering either

Transition to SURVIVAL mode should not require notification or commands be sent to the

2663 OPERATION or SAFE modes.

mode.

Instrument.

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2664 2665 2666 2667	Exiting initialization Mode When in INITIALIZATION mode, the Instrument should remain in INITIALIZATION mode until a valid command is received from the Spacecraft or ground operations team to transition to OPERATION (or SAFE) mode.
2668 2669 2670 2671	SAFE Mode Transitions Command Trigger The Instrument should transition to SAFE mode upon receipt of a command from the Spacecraft or ground operations team.
2672 2673 2674	Missing Time Message Trigger The Instrument should transition to SAFE mode upon the detection of 10 consecutive missing time messages.
2675 2676 2677 2678	On-Orbit Anomaly Trigger The Instrument should transition to SAFE mode autonomously upon any instance of an Instrument-detected on-orbit anomaly, where failure to take prompt corrective action could result in damage to the Instrument or Spacecraft.
2679 2680	Orderly Transition The Instrument should conduct all transitions to SAFE mode in an orderly fashion.
2681 2682 2683	Duration of SAFE Mode Transition The Instrument should complete SAFE mode configuration within 10 seconds after SAFE mode transition is initiated.
2684 2685 2686 2687	Instrument Inhibition of SAFE Mode Transition The Instrument should not inhibit any SAFE mode transition, whether by command from the Spacecraft or ground operations team, detection of internal Instrument anomalies, or lack of time messages from the Spacecraft.
2688 2689 2690	Deliberate Transition from SAFE Mode When in SAFE mode, the instrument should not autonomously transition out of SAFE mode, unless it receives a mode transition command from the Spacecraft or ground operations team.
2691 2692 2693 2694	OPERATION Mode Transitions Trigger The Instrument should enter OPERATION mode only upon reception of a valid OPERATION mode (or sub-mode) command from the Spacecraft or ground operations team.
2695 2696 2697 2698 2699	Maintenance of OPERATION Mode When in OPERATION mode, the Instrument should remain in the OPERATION mode until a valid command is received from the Spacecraft or ground operations team to place the Instrument into another mode, or until an autonomous transition to SAFE mode is required due to internal Instrument anomalies or lack of time messages from the Spacecraft.

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Appendix H Significant Differences among CII, ESA, and SMC Hosted Payload Guidelines

Table H-1: Cll and ESA Hosted Payload Technical Guideline Differences

Interface	NASA	ESA	Comments
Data Interface	SpaceWire, RS422, Mil-STD-1553	SpaceWire	
On-board data storage	Instrument	Spacecraft	
Power	28 ± 6 VDC	18 to 36 VDC	
Discrete PPS line	Optional	Required	
Redundancy	Optional	Required	Data, power, Survival Heaters
EMI/EMC	Tailored MIL-STD- 461F Based on inputs	Will be tailored from MIL-STD-461F	Inputs from RFI responders
Overcurrent protection	Open	Latching Current Limiters (LCL)	